NAVAL POSTGRADUATE SCHOOL
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THESIS

DESIGN OF A RELIABLE COMPUTING SYSTEM
FOR THE PETITE
AMATEUR NAVY SATELLITE (PANSAT)

by

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March 1989

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 This thesis proposes a processor design for the Petite Amateur Navy Satellite (PANSAT). The missions of PANSAT are considered. It compares the design of three previous satellites with similar missions and determines the processor functions required to support PANSAT missions. Particular attention is given to the store and forward message system. A reliable processor design that implements these functions is developed. The reliability of the proposed design is examined. Minimum software requirements for the resulting design are listed.

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Design of a Reliable Computing System for the Petite
Amateur Navy Satellite (PANSAT)

by

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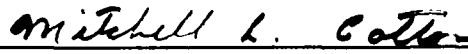MASTER OF SCIENCE IN ELECTRICAL ENGINEERING

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ABSTRACT

This thesis proposes a processor design for the Petite Amateur Navy Satellite (PANSAT). The missions of PANSAT are considered. It compares the design of three previous satellites with similar missions and determines the processor functions required to support PANSAT missions. Particular attention is given to the store and forward message system. A reliable processor design that implements these functions is developed. The reliability of the proposed design is examined. Minimum software requirements for the resulting design are listed.

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I. PROBLEM DEFINITION

A. PURPOSE

The purpose of this study is to lay out the requirements of the on-board processor for the Petite Amateur Navy Satellite. Once the requirements are fully established, a design will be specified that meets the requirements. This design will include the division of labor between software and hardware. Finally, the hardware reliability will be examined.

B. THE PETITE AMATEUR NAVY SATELLITE

The Petite Amateur Navy Satellite (PANSAT) is a small, simple, and inexpensive satellite currently being designed at the Naval Postgraduate School. PANSAT is intended to be a space-based communications experiment that provides students with hands-on experience in satellite design and operations. It will accomplish three objectives. First, it will serve as an educational tool for NPS students, offering them experience in satellite design and operations. Second, it will prove NPS capability in satellite design. Third, it is the first step toward the Space System Academic Group's ultimate goal of producing the ORION satellite. It is a simpler and less capable satellite than ORION. Therefore, it can be produced for a fraction of the cost of the final version of ORION. Simplicity and reduced cost will help minimize the risks inherent in a first design. A tentative launch date has been set for July, 1991. [Ref. 1: p. 1]

1. Background

The ORION project has been in progress for several years at NPS. The goal is to design and launch a small, general purpose satellite bus. While the ORION design is nearly complete, it has the disadvantage of being a complicated and expensive first attempt at satellite design. Before ORION can be fully funded, NPS must prove its capability by designing and operating a simpler satellite. PANSAT is the vehicle intended to prove this capability. PANSAT will be less than half the size of ORION. In addition, although ORION will be attitude stabilized, PANSAT will have no attitude control. A successful launch and operation of PANSAT will provide the ORION project with the additional groundwork and data to serve as a baseline on which to build.

2. Mission

The primary mission of PANSAT is to conduct a space-based communications experiment which will provide students with experience in design and operation of such

a system. The desired implementation is a store and forward message system. This allows an authorized user to input a message while the satellite is overhead. At a later time, another authorized user can review the message subjects carried by the satellite and retrieve those of interest. Outdated or retrieved messages can be deleted. Telemetry or orbital data can also be collected on-board and stored as messages.

In addition, several secondary missions are being considered. These would include carrying small sensors for other experiments if volumes and weights permit. Various programs could be loaded into the satellite processor, allowing students experience in writing software kernels for satellite control. These programs could also be modified to monitor memory errors over time, allowing students to evaluate effects on memory circuits from exposure to increased radiation and harsh environment. If sensors are included, power usage by memory and processor components could be measured over time to further evaluate exposure effects on semiconductor products. The more inherent flexibility available on-board to reconfigure the processor, the greater the possibility that additional experiments can be programmed and implemented.

Underlying these experiments is the primary mission of educating students in space design and operations. This goal will be achieved by involving students at all levels of design and operations. Furthermore, increased processor flexibility will maximize opportunities for student involvement by permitting additional experiments.

3. PANSAT Design

The following are working design constraints that impact on the processor system design.

a. Orbit

The first PANSAT is planned for launch from the space shuttle without any extra booster. This constrains the satellite to a low earth orbit of approximately 150 to 200 nautical miles. Actual orbit will depend on shuttle parameters of the particular mission that launches the PANSAT. Typical orbits have a 90 minute period at an inclination of 28.5 degrees [Ref. 2: p. 2] The orbit will also determine communication opportunities with the satellite. These orbits will provide only one or two ten-minute communications windows per day for any particular ground station.

b. Size

The Get Away Special canister size limits the physical size of the satellite. If a regular size canister is used, this limits satellite size to approximately 19 inches in length by 19 inches in diameter. Working within these limits, a octagonal cross section design is planned to maximize solar collector area. The planned overall dimensions of

the PANSAT are shown in Figure 1 on page 4. The volume within the satellite allocated for the processor is shown in Figure 2 on page 5.

c. Stabilization

The PANSAT will not be stabilized and will not have any station keeping ability. This eases requirements on processor capability because the processor will not be required to monitor any attitude sensors or perform stabilization calculations. One drawback is the requirement for multiple antennas to enable uninterrupted communication with the satellite as it tumbles overhead. The restriction to omnidirectional antennas will negatively impact the communications power budget. Lack of attitude control also implies that thermal control will have to be passive.

d. Communication

Communication with the PANSAT will be in the 144-146 MHz band. The type of communication protocol remains to be specified. Options for the physical transmission method are using voice band transmitters and receivers with modulators and demodulators performing the required analog to digital conversion or using a direct digital method. The protocol for controlling transmission is yet to be determined. The data rate will be limited to not more than 9600 bits per second and will be in a serial format. The reason for the 9600 bps limitation is two fold. First, a low data rate will conserve power on the satellite. Second, it will allow a small computer to be used as the basis for a ground station.

e. Power

The satellite will be powered by an array of solar cells mounted on the exterior. These will charge a bank of 28 two volt, five amp-hour sealed lead-acid batteries. This will provide a 28 volt, redundant bus. The power system has not been designed, but initial estimates indicate that three watts of continuous power may be used. A peak power usage of 50 watts is envisioned; this usage will be sustained only during the time the satellite is communicating with a ground station. During the remaining portion of the orbit the satellite will be quiescent, providing an opportunity to recharge the batteries. [Ref. 1: p. 2]

f. Durability

The satellite will be subjected to high vibration during launch and orbital injection. The overall root mean squared vibration level is 12.9 g's for 40 seconds [Ref. 2: p. 57]. The processor (as well as the entire satellite) must be able to withstand these stresses without failure.
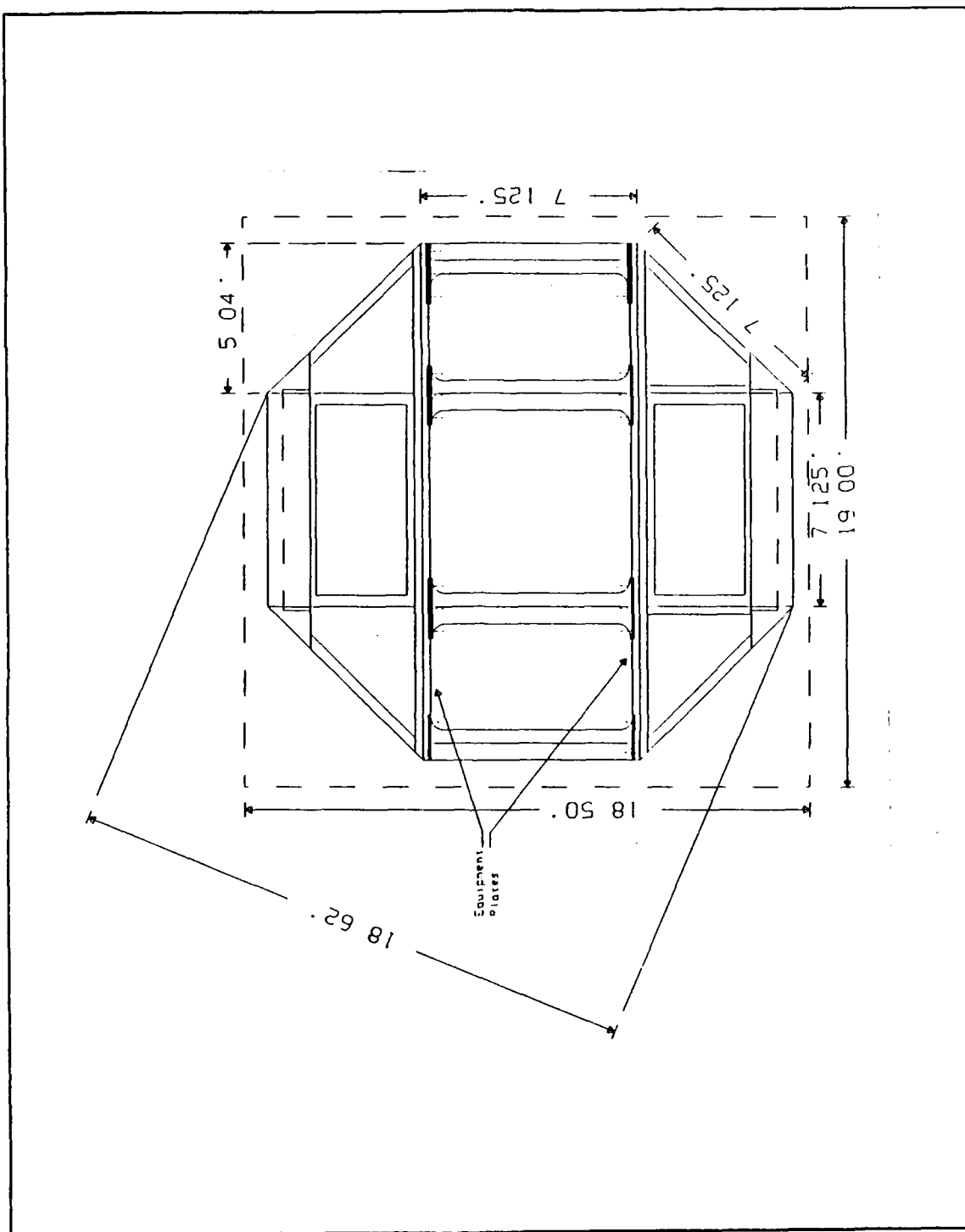
Figure 1.   PANSAT Overall Dimensions

Figure 2. **PANSAT Processor Envelope**

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g. *Lifetime*

The processor must be able to function properly during the satellite's design lifetime of one and one half years. The design should be such that system failure can be avoided. If a fault occurs, the design should minimize the impact on the mission by redundancy (appropriate to the relative simplicity of the satellite) or by allowing the processor to work around the fault.

C. PANSAT FUNCTIONS

The following functions are to be performed by the satellite.

- Interrogation response: When interrogated by a specified command tone (or combination of tones), the satellite will respond (in a manner to be determined).

- Orbital store and forward message service: The satellite will be capable of receiving messages via a communications link, storing the messages, and transmitting them upon request.

- Flashing strobe lights on command: When a specified command is received, the satellite will flash externally mounted strobe lights.

The specific format and limitations of these functions are to be determined in the course of this design study. In addition to the functions listed above, the processor must manage housekeeping functions in support of the mission functions. These support functions include, but are not limited to:

- Control of communications between the satellite and ground stations, including positive control over the on-board transmitter(s).

- Management of the mailman message buffer.

- Power management and battery charging, including sleep and wake commands.

- Generation and formatting of status messages.

- Reception, decoding, and execution of commands from the ground control station.

- Fault detection and recovery.

- Ability to update or change programming.

- Storing telemetry data in an on-board buffer (perhaps the store and forward buffer) for later relay to ground station.

D. ENVIRONMENT CONSTRAINTS

The satellite will operate in low earth orbit, imposing certain constraints on design. First, the atmosphere will be close to vacuum. Temperature will range from -160°C to +100°C [Ref. 2: p. 65]. No active cooling is envisioned for the satellite. Operating outside the protection of the atmosphere will expose the satellite to solar and Van Allen radiation. Second, power will be limited by what can be provided by the solar cells.

Third, the orbit will limit communication with the satellite from any particular ground station to approximately 10 minutes each pass. Finally, once launched, the satellite will be inaccessible for repairs.

E. DESIGN CONSTRAINTS

The small size of the satellite will impose additional constraints on the processor design. The processor must have a small volume and weight. The weight constraint is not anticipated as a problem due to the small size and weight of currently available processors and peripherals. The available volume and footprint for the processor assembly is shown in Figure 2 on page 5. The system must be able to withstand the stresses of launch and orbital insertion.

F. DESIGN ENHANCEMENTS

The following items, while not design requirements, are preferred enhancements. They should be achieved if possible within space, power, weight, and cost considerations.

1. Commonality

The processor should be similar to one commonly available, preferably one in current use at NPS. This will simplify program development and allow increased educational benefits. Program development is simplified by the larger number of software packages (specifically compilers and assemblers) available for a common processor. It is very desirable that the processor chosen have available high level language compilers to allow programming the processor in C or an equivalent language. The educational benefit is enhanced by allowing students to develop a program on a ground-based computer. Once debugged and verified it can be uploaded and tested on an actual satellite.

2. Upwardly compatible

The processor should have enough capability to expand easily to meet the additional computing requirements of ORION. These will include the capability to supervise the attitude control of the enhanced version. The processor will also have to manage communications with an on-board experiment, either by formatting and passing messages, or by exerting direct control over the experiment. ORION may carry a system to relay video images to a ground station. This implies a higher data rate on the ORION communication link than on the PANSAT communication link. A solid state bubble memory recorder is a candidate processor that will require interfacing with the processor. The PANSAT processor should have a growth margin to meet these future needs of ORION. In addition, if a single processor design is used it should be easily upgradable to a multiple processor configuration for these future requirements.

3. Real time clock

A real time clock accessible through the processor is a possible enhancement. This would allow processor events to be scheduled for a specific time.

G. RESEARCH QUESTIONS

The research questions for this study may be identified as:

* What computing power is required?

* What processor(s) will meet this requirement?
  Should the approach be a microcontroller giving a potential single-chip design. or would a microprocessor design be more appropriate (with the larger chipset and footprint implied)?

* What will be the layout of the system?
  Single processor versus multiprocessor. If multiple processors are used, should the system be tightly coupled or loosely coupled.

* What is the proper division of tasks between software and hardware?

* How will the computer system interface to:

  1. Power system, including batteries and solar cells?

  2. Communications system.

  3. Strobe lights.

  4. Any other on-board sensors.

* What size of RAM and ROM is required.

* What amount of radiation hardening is required?

* What additional hardware (especially RAM) is required to support the store and forward function. Does this have a lower reliability standard?

* What amount (if any) of security must be provided to prevent unauthorized control of the satellite?

* How will communications with the satellite be handled? Will all communications go through the processor, or will there be a dedicated telemetry and command link? Will a custom communications protocol be used, or will a standard method be adopted?

Specific software development will not be addressed beyond what is required to ensure that the required functions will in fact be programmable (with a given margin for growth) within the hardware that is developed.

H. CANDIDATE PROCESSORS

The processor upon which the system is based should be commercially available in a low power, radiation hardened version. The following processors are candidates for consideration:

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- 8085 or equivalent 8 bit microprocessor.
- 8086 or equivalent 16 bit microprocessor.
- Z80, Z280 or NSC 800 8 bit microprocessor.
- MC68000 16 bit microprocessor.
- MC68HC11 microcontroller.
- 8096 microcontroller.

I. COMMUNICATIONS PROTOCOLS

The protocol used for communicating between the satellite and a ground station will impact on processor design. The first question is what protocol to use. Either a standard protocol, such as X.25, or a custom-designed protocol may be implemented. If a custom protocol is required, the error detection methods must be specified. If a standard communications protocol is to be used, what amount of computing must the software do and what amount will be done in specialized hardware? When referring to the seven layer ISO model for computer communication (see Table 1), which layers are handled in software and which in hardware? The physical layer, which includes the communications equipment, is implemented in hardware. The second and third layers may be implemented in either software or hardware. Levels four and above are typically software based, and may not all be needed. Elimination of higher levels will simplify software requirements, and therefore hardware requirements, on the satellite.

Table 1. ISO SEVEN LAYER MODEL

Highest level	7.	Application layer
	6.	Presentation layer
	5.	Session layer
	4.	Transport layer
	3.	Network layer
	2.	Link layer
Lowest level	1.	Physical layer

J. DESIGN SCOPE

The conceptual design breakdown of PANSAT is shown in Figure 3 on page 10. The processor is a central portion of the design as it interfaces with all other systems.

This design concentrates on the block labeled hardware design. Since most other areas are still conceptual, assumptions are made and defended where necessary.
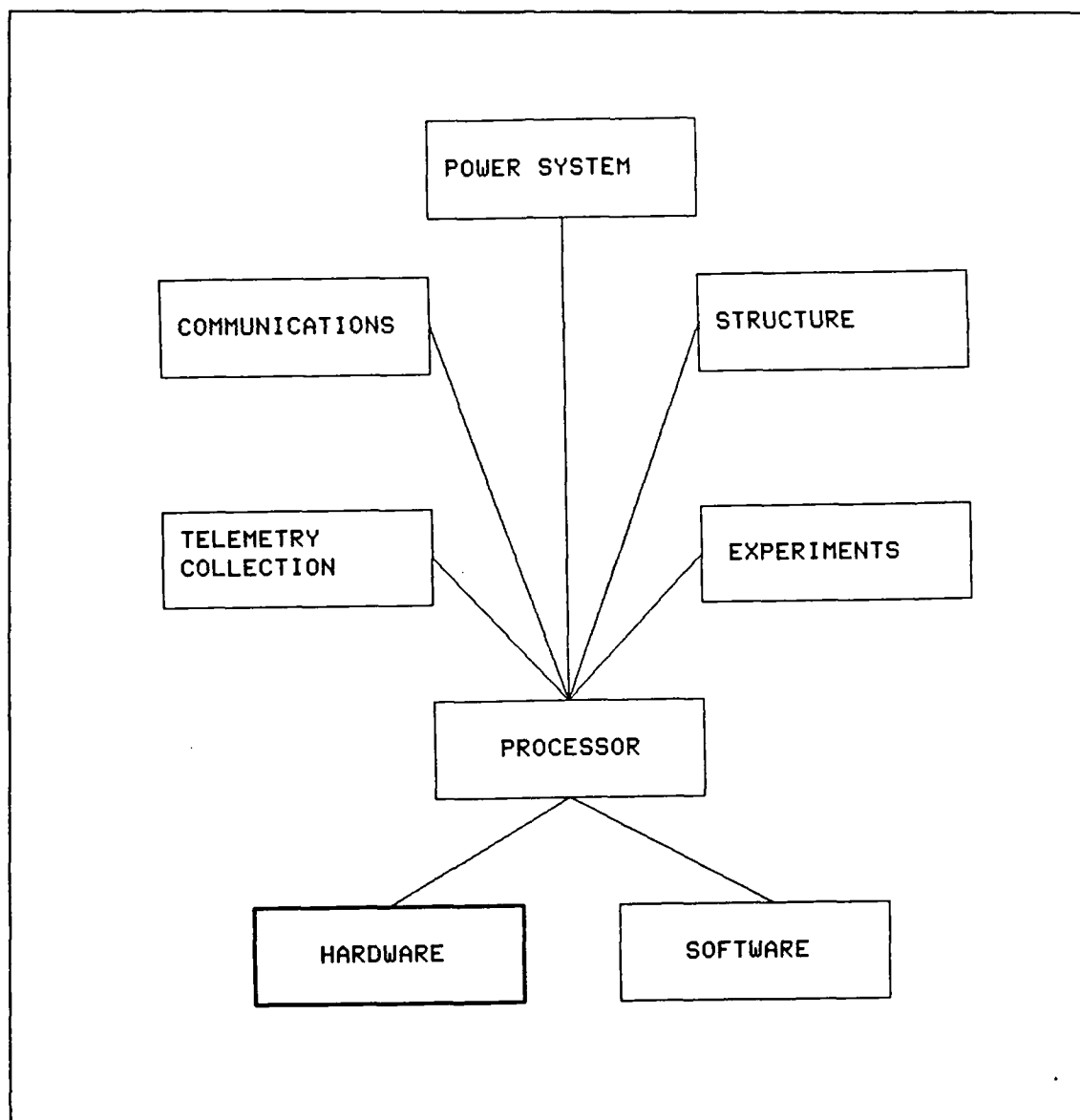
Figure 3.   PANSAT conceptual design

II. SYSTEM REQUIREMENTS ANALYSIS

A. PREVIOUS DESIGNS

Many amateur satellites have been constructed over the years. These designs are an important starting place because the capability is similar to that desired for PANSAT. Three designs are of special interest. These are the UoSAT-2, UoSAT-D, and FO-12 satellites. Pertinent design features of the processors on these satellites are summarized in Table 2.

Table 2. SATELLITE PROCESSOR SUMMARY

Satellite	UoSAT-2 (Oscar-11)	FO-12 (Oscar-12)	UoSAT-D
Purpose	digital comm experiment	orbital mailman	orbital mailman
Processor	NSC-800 (Z-80)	NSC-800 (Z-80)	80C186
	3 cards 6"x9"x1"	10 cards 6.3"x5.91" 329 ICs	
	0.9 MHz	1.7 MHz	8 MHz
Comms	MSG-2	AX.25	AX.25
	UARTs	discrete HDLC controller 3 cards 6.85"x8.74" 144 ICs	
		4 uplink 1 downlink	
	1200 bps	1200 bps	9600 bps
Power	1 watt	3.5 watts	(not given)
Memory	126 kbyte static RAM	1 Mbyte dynamic RAM	4 Mbytes
	512 bytes PROM (redundant), 16 kbytes of RAM have one bit EDAC	(No SRAM or PROM), 32 kbytes kernel, stack, and static, 4 x 256 kbyte cards bank switched, 1 bit EDAC	
Attitude control	gravity boom, active magnets	spin, passive magnets, lossy dampers	gravity boom, active magnets

1. UoSAT-2

THe UoSAT-2 was designed as a digital communications experiment to prove technology to be used in follow-on satellites. It utilized a NSC-800 processor (similar to a Z-80) running at 0.9 MHz. The communications link operated at 1200 bits per second utilizing a custom message protocol. This custom protocol, MSG2, was used due to lack (in 1985-86) of a low power CMOS HDLC controller chip or room for a discrete HDLC implementation. This protocol is byte oriented. The MSG2 frame format is shown in Figure 4. Byte stuffing is used to ensure the frame marker, [10h][03h], does not occur within the frame. When [10h] is to be transmitted, it is changed to [10h][10h], then re-converted after reception. The kernel implementing MSG2 was written in Z-80 assembler code and occupies 2.5 kilobytes of error detection and correction protected (EDAC) RAM. Ground stations must have a custom software package to communicate with this satellite. [Ref. 3]

```
[10h][03h]  <command>  <command not>  <data length>  (data)  < <CRC> >


 <  >  indicates byte data
 < <  > >  indicates 16 bit data
 ( ) indicates variable length, defined by data length byte
```

Figure 4.   MSG2 protocol frame format

There are several ideas used in the UoSAT-2 that may be applicable to the PANSAT design. These are:

- Successful use of commercial grade RAM chips in a low earth orbit environment.

- Error detection on vital RAM (non-vital RAM does not have error detection).

- Whole orbit telemetry monitoring using message RAM to store data for downlink while satellite is overhead.

2. UoSAT-D

The UoSAT-D satellite is a packet communications experiment that builds on UoSAT-2. UoSAT-D implements the AX.25 packet radio protocol operating at 9600 bits per second in full duplex mode. It utilizes a 80C186 processor operating at 8 MHz. This processor has sufficient processing capacity to handle all the satellite's internal

housekeeping concurrent with packet radio operation. UoSAT has developed software for the ground stations that is available if the AX.25 protocol is adopted. [Ref. 4]

3. FO-12

The FO-12 satellite is a store and forward digital maiibox. It implements the AX.25 protocol with four uplink channels and one downlink channel, all operating at 1200 bits per second. The AX.25 protocol was implemented in discrete CMOS logic. No ROM was used in FO-12. Initial program load was accomplished via hard-wired logic. [Ref. 5]

B. RADIATION EFFECTS ON CMOS DEVICES

The processor for PANSAT will be constructed mostly from complementary metal oxide semiconductor (CMOS) integrated circuits. The advantage of CMOS is the extremely low power consumption exhibited by these devices. Low power consumption also implies reduced generation of excess heat, an important consideration in a satellite with only passive thermal control. In addition, power consumption can be controlled by regulating the frequency of operation. (Lower speeds require lower power.) However, CMOS circuits can be adversely affected by radiation in the space environment.

The interaction of particles and energies can actually be broken down into two main mechanisms which dominate the effect of radiation in materials in which we are concerned: 1. Displacement of atoms from their lattice structure (displacement damage). 2. Generation of electron-hole pairs (ionization). Both effects can cause temporary (transient) or permanent damage to semiconductors. [Ref. 6: p. 2-5]

Radiation hardened circuits are designed to minimize the long term effects of radiation. However, this hardening makes the circuits much more expensive than equivalent industrial quality devices. Memory devices are especially affected by increased cost. Since radiation damage occurs over time, it may be possible to use a mixture of industrial quality and radiation hardened components to meet the lifetime requirement for PANSAT.

A second type of disturbance occurs specifically in memory devices. A high speed particle may traverse through the semiconductor leaving an ionized path. This ionization may be sufficient to cause a static inverter to change state, or a dynamic storage element to lose charge. In the worst case, the particle will leave an ionization path through to the substrate and cause latch-up. Either process will cause corruption of at least one bit of memory. Latch-up will result in increased current draw and will require removing power from the circuit to reset the condition. Temporary loss of a bit, while corrupting the stored value, can be remedied by rewriting the affected word. When the disturbance

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is temporary and can be remedied by rewriting the affected value, it is termed a single event upset (SEU). Like permanent damage effects, SEUs can be reduced by using radiation hardened memory devices. While the physical process that causes these events is known,

> ...prediction and simulation of the SEU rate for a given satellite in a given orbit are very inaccurate. The SEU rate depends on: memory device manufacturing technique, device geometry, shielding, satellite orbit, satellite attitude, solar activity, (and) geomagnetic activity. [Ref. 3]

The UoSAT-2 experiment experienced 21 SEUs in a period of 185 days in 144 kilobits of industrial quality memory. The equivalent shielding of the memory was not specified. Since the orbit of PANSAT will be lower than UoSAT-2, SEU rates will probably be lower, reducing the requirement for error detection and correction. [Ref. 3]

C. INTEGRATED CIRCUIT SCREENING LEVELS

Device screening and qualification varies depending on the manufacturer. Specific quality requirements for government applications are established in MIL-STD-883 and MIL-M-38510. These standards establish quality requirements for military Class B, Class S, and radiation hardened devices. Class B qualification is required for devices used in typical military applications. Class B screening includes a 100% burn-in test at +125°C to weed out potentially defective items. Class S qualification places the most stringent requirements on the devices. Testing begins with wafer lot acceptance. All devices are subjected to a bond pull test where each connecting wire from the die to the package is tested to ensure that it will not detach. These devices are individually serialized. The circuit is burned-in at +125°C for 240 hours, then reverse biased at +150°C for 72 hours. Other statistical and electrical checks are performed, ending with two separate x-ray views of the device. Due to the stringent test requirements of Class S qualification, few devices survive screening. This makes the cost of Class S devices considerably higher than devices tested to lower standards. In addition, few manufacturers perform Class S screening; this screening is typically on a custom order basis. Manufacturers often provide Class B or Class S 'look alikes.' These devices follow a flow that is similar to MIL-STD-883 but may be obtained at a lower cost. The basic screening levels are summarized in Table 3 on page 15. [Ref. 6: pp. 13-8 to 14-21]

In following sections, high reliability devices will indicate those that meet the JAN Class B screening. Radiation hardened will indicate devices that are certified with

MIL-STD-883 Group E radiation hardness assurance tests in addition to the Class B screening.

Table 3.   DEVICE SCREENING LEVELS

Level	Temperature range (°C)	Screening includes:	Representative cost (8086)
commercial	0 to +70	statistical	S22
industrial	-40 to +85	statistical, may require burn-in	S38
military (High reliability, JAN class B)	-55 to +125	100% testing, burn-in 160 hours at +125°C	S261
radiation hardened		Samples from each wafer subjected to radiation tests	S800
military (space qualified, JAN class S)	-55 to +125	100% serialization and exhaustive testing, burn-in 240 hours at +125°, x-ray after burn-in.	greater than S2000 for Class S look-alike

D. DESIGN INTERFACES

The PANSAT processor will interface with all satellite systems. The major subsystems are:

- Communications system
- Power supply and battery charging system
- Experiments
- Structural system

In addition, the processor hardware will interact with the processor software to accomplish assigned tasks. At present, only the PANSAT structural system has been designed. Since the other systems are not yet designed, this design will make educated assumptions about these other systems and required interfaces. These assumptions may prove incorrect in the long term, but they provide a starting place for the processor design.

E. PROCESSING POWER

The processing power required in PANSAT is dependent upon the tasks assigned to the processor. These tasks can be divided into four categories:

- communications
- housekeeping
- telemetry
- command execution

The communication task will consume most of the processor capability so it was investigated first.

1. **Communications**

    a. *Number of communication links*

    Previous satellites designed to accomplish a mission similar to PANSAT have used at least two communication links. One link is a specialized channel to transmit commands to the satellite and receive telemetry data from the satellite. The second channel (in some cases several channels) implements the digital store and forward message system. Many users have access to the store and forward channel operating in a known format. Only the ground control stations know the correct format and frequencies for the command channel. The digital message channel can also be used by the controlling station to upload revised programming. Use of more than one channel gives the satellite redundancy. If the command channel fails, the message channel can be used to send commands to the satellite. Telemetry can be sent either over the dedicated channel, or can be collected by the processor, formatted, then sent over the digital communication channel. The disadvantage of this approach is that two separate transceivers must be located in the satellite. The size of PANSAT precludes using two transceivers. Restriction to a single communications link requires this link to accomplish all functions.

    Use of a single communications link makes the hardware design of the processor simpler. The tradeoff will be in the software which must become more complex to handle the following tasks over the single channel:

- Command uplink, including satellite reprogramming.
- Telemetry downlink.
- Store and forward message system.
- Hardware reset to restart system on program malfunction.

The link must then be designed to embed the commands in the store and forward message format. Telemetry downlink will be placed into the message buffer and received as a forwarded message. Since a single link will be used which is accessible to amateur

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radio operators, a security system is required in software to prevent an unauthorized user from reprogramming the satellite or inadvertently sending the reset sequence.

This assumption of a single link is the most restrictive case. When the communications system is designed, it may prove possible to multiplex the digital link and a separate command link. If this is possible, this design will still be valid, with the separate link adding redundancy.

b. Communications protocol

The options for a communication protocol are to design a custom protocol or to use a standard protocol. The advantages of a custom protocol are that the capabilities of the specific satellite can be maximized. However, the disadvantages of using an unproven protocol, which include requiring a custom software implementation for both ground stations and the satellite, outweigh any possible benefit. Additionally, if a custom protocol is used, this will limit satellite accessibility to amateur radio operators.

AX.25 and MSG2 are the two probable choices for a standard protocol. MSG2 was illustrated previously in Figure 4 on page 12. AX.25 is an extension of the standard X.25 data link control protocol. AX.25 extends the address field to allow encoding of amateur radio operator callsigns. Callsigns of up to six letters (one letter per byte, with an additional byte for secondary station identifier) are included for both sender and receiver. Up to eight repeater stations may be used, extending the address field to 512 bytes. The X.25 and AX.25 formats are shown in Figure 5 on page 18. AX.25 is a bit oriented protocol. The flag '01111110' is used to signal the beginning and end of a frame. The flag is prevented from occurring within the frame by inserting a '0' after any sequence of '11111.' This process, called bit stuffing, is compensated by the receiving station removing any '0' after a sequence of '11111.' [Ref 7: pp. 1-9]

The differences between MSG2 and AX.25 are summarized in Table 4 on page 19. Significant differences are the type of automatic repeat request (ARQ), information frame length, and orientation (bit versus byte oriented). The ARQ and frame length differences combine to determine maximum possible throughput. Processing power required is affected by whether the format is bit or byte oriented.

To compare maximum theoretical throughput, the distance to the satellite must be determined. Assuming the satellite is orbiting 370 kilometers above the earth (H), using 6378 kilometers as an average earth radius (Re), and presuming the satellite elevation (E) must be above ten degrees for successful communication, the slant range to the satellite (d) is given by: [Ref. 8: p. 45]

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X.25 DLC Protocol

8 bits	8 bits	8 bits	Variable (N·8 bits)	16 bits	8 bits
Flag	Address	Control	Packet	CRC	Flag
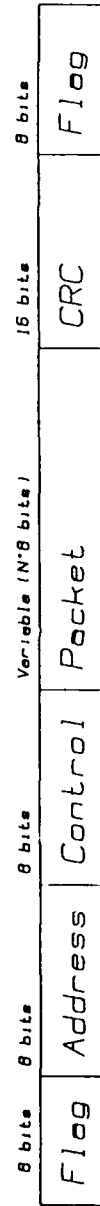
Flag = 01111110

Bit stuffing is used to prevent Flag from appearing in packet.

AX.25 DLC Protocol

8 bits	112 to 560 bits	8 bits	8 bits	Variable (N·8 bits)	16 bits	8 bits
Flag	Address Field	Control	PID	Information	CRC	Flag
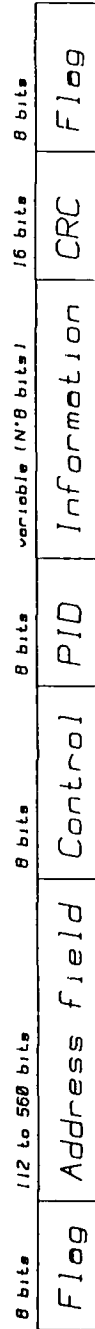
Extension of address field allows for encoding callsigns of sender, receiver, and up to eight relay stations.

Figure 5.   X.25 and AX.25 Data Link Control Protocols

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Table 4. COMPARISON OF MSG2 AND AX.25

Protocol	MSG2	AX.25
Orientation	byte serial	bit serial
ARQ	selective repeat	go back N
l frame length	up to 64 bytes	up to 256 bytes (*)
Overhead	7 bytes	20 to 76 bytes
* Some implementations may have a lower limit		

$$d^2 = (Re + H)^2 + Re^2 - 2Re(Re + H) \times \sin[E + \sin^{-1}(\frac{Re}{Re + H} \cos E)] \qquad (1)$$

This gives a value of 1359 km for the maximum slant range. The minimum slant range will occur if the satellite is directly overhead at 370 km. Most communication will be done at a value between these two extremes. Since the satellite will rarely pass directly overhead, a nominal communication range of 1000 km will be assumed to compare throughput for the AX.25 and MSG2 formats.

AX.25 uses go back N format, where N is eight. The throughput, ρ, for this format is given by: [Ref. 9: p. 222.]

$$\rho = \frac{1 - P}{1 + \frac{2Tp}{Tf} P} \qquad (2)$$

- P is the frame error probability: $P = 1 - (1 - Pb)^{Nb}$
- Pb is the probability a single bit is in error.
- Nb is the number of bits in a frame.
- Tf is the time required for transmission of a frame.
- Tp is the propagation and processing delay.

MSG2 is a selective repeat format. The throughput for selective repeat is given by: [Ref. 9: p. 233]

$$\rho = 1 - P \qquad (3)$$

where P is given above.

A minimal AX.25 frame will have 20 bytes of overhead. Assuming a ten percent overhead, this give an I frame size of 200 bytes, or 1600 bits. This overhead is similar to a 71 byte MSG2 frame, which has 7 bytes of overhead. The throughputs for these protocols are compared in Figure 6 on page 21 using these assumptions. As bit error rate increases, throughput drops more rapidly for AX.25 than for MSG2. Most of this difference comes not from protocol differences, but from the frame size effect on frame error probability. The frame error probability for AX.25 could be reduced by decreasing frame size. This would increase the fraction of overhead since the 20 byte overhead cannot be avoided. In a frame addressed through repeaters, overhead could increase to as much as 76 bytes. As long as single bit error probability remains below 3×10^{-4}, throughput for AX.25 is acceptable. This requirement to maintain low bit error rate must be included in the design of the communication package for PANSAT.

MSG2 is a byte oriented protocol. The processor does not require any additional hardware or special algorithms to implement the protocol. All that is necessary is to examine the byte stream for the byte [10h]. This can be done by a simple comparison. In contrast, AX.25 is a bit oriented protocol. The flag '01111110' can occur anywhere in the bit stream, not just as a byte. This means that the entire bit sequence must be examined to detect any sequence of '11111' which must then be stuffed to prevent the flag from occurring within the frame. This requires either a dedicated data link control (DLC) protocol hardware device or complicated software algorithms.

Although AX.25 has a lower throughput than MSG2 and will be more complicated to implement, this is the protocol that will be implemented on PANSAT. This protocol is the current standard used for communication with amateur satellites. If this protocol is used, ground station testing can be conducted with amateur satellites presently in orbit. In addition, once PANSAT is in operation, other amateur ground stations will be able to access PANSAT's store and forward message system.

The processor must be able to perform the bit stream formatting required in AX.25. The communication link must be designed to maintain a bit error rate that does not adversely affect traffic throughput.

c. Implementation of AX.25 communications protocol

The communications protocol can be implemented either in software or by dedicated hardware support. A software implementation of AX.25 will not be considered. Although it is theoretically possible to implement, the task of examining the bitstream bit by bit and computing the CRC checksum for both an incoming and

Percent of ideal throughput versus bit error probability
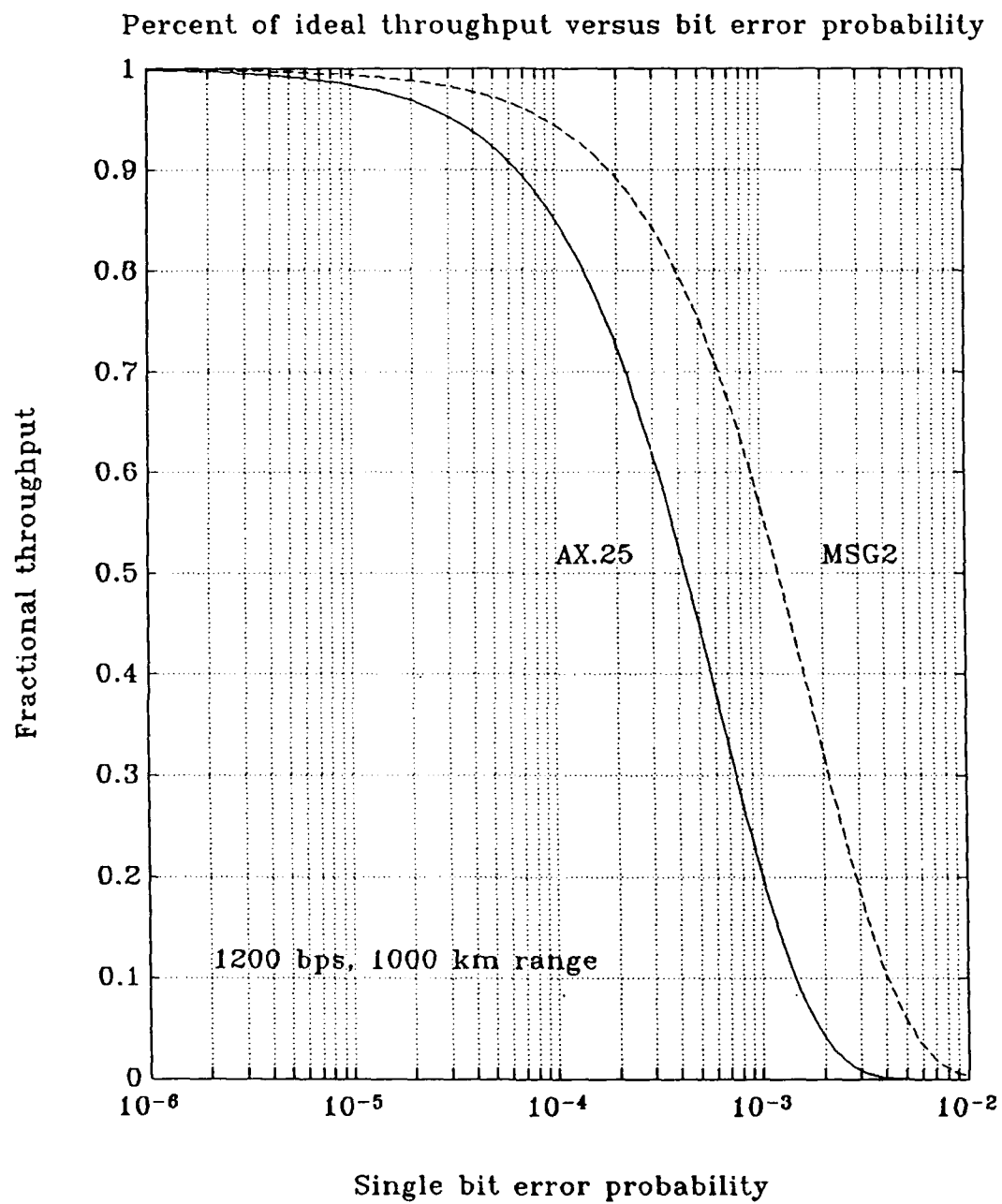
Figure 6.   Throughput comparison of AX.25 and MSG2

outgoing channel at 9600 bps will severely task the software designer. Software implementation will only be considered if a hardware solution proves unfeasible.

If a hardware implementation is used, the designer typically has three different methods of controlling the hardware protocol chip. These are:

- polled
- interrupt driven
- direct memory access

In a polled system, the processor must regularly interrogate the protocol chip to determine if the chip is ready for input or output. In an interrupt configuration, the chip will interrupt the processor when it requires data transfer. In a direct memory access system, the processor stores the data parameters in the DMA controller and then initializes the chip. The data transfer then takes place with no further intervention from the processor. The DMA processor will then inform the processor when the transfer is complete.

The polled system is the easiest to implement and requires little additional circuitry to perform. The disadvantage is that additional software complexity is required to allow the processor to accomplish other tasks while waiting to transfer data to the protocol chip. The DMA arrangement allows higher transfer rates as the processor is not involved in transfers. The DMA controller 'steals' cycles from the processor to transfer data without requiring processor intervention other than to temporarily relinquish the system bus. However, the DMA controller implies additional circuitry not required by the other implementations. In addition, the DMA controller is not available in a radiation hardened version.

PANSAT requires an interrupt controller for several functions detailed in following sections. Therefore using an interrupt structure to service the hardware protocol chip will not add to circuit complexity. Table 5 on page 23 shows a possible interrupt service routine used to provide data from a 8086 processor to a 8273 HDLC protocol controller. Assuming the processor operates at 5 MHz (with no wait states) then 163 clock cycles equates to 32.6 microseconds. At 9600 bits per second, the processor needs to process 1200 bytes per second, or one byte every 833.3 microseconds. In full duplex mode, there is one incoming byte and one outgoing byte every 833.3 microseconds, each taking 32.6 microseconds. The fraction of available processor time used for HDLC control is 0.078. Thus using the processor to operate the

communications link on a byte by byte interrupt basis only requires about 8 percent of available processor time.

Table 5.   8086 INTERRUPT ROUTINE TO SERVICE 8273

Instruction	Clock cycles	Comment
complete current instruction	10	(assumed average, not included in total)
Interrupt processing	61	push CS, IP, FLAGS, get interrupt vector, and branch to service routine
PUSH AX	11	save register
PUSH BX	11	
MOVE AL,[SI]	8 + EA = 14	get next byte
OUT #HDLCOUT,AL	10	output to 8273
INC SI	2	point to next item
MOVE #RSTINT,AL	4	
OUT #INTPROC,AL	10	reset interrupt controller
POP BX	8	restore registers
POP AX	8	
IRET	24	
Total:	163	

d.   Higher layer protocols.

Although AX.25 has been selected for use, this is only the second layer protocol. This will transmit error free packets between the satellite and a groundstation. Higher level interfaces are required to reassemble these packets into complete messages. These higher level protocols must also determine what action to take with the message. These actions may include:

• add message to the buffer,

• retrieve message from the buffer,

• list buffer messages,

• issue satellite command or load a program, and

• transmit telemetry data.

These commands are a function of the software, not the hardware implementation, and will not be considered further. (Higher layer software for the satellite and ground stations may be available from AMSAT.)

e. Transmitter control

A major concern for getting the PANSAT design approved for launch is demonstrating positive control over the transmitter. If the satellite has a malfunction, there must still exist means to secure the transmitter from the groundstation. Legally, telecommand capability is necessary:

> ...to turn off a malfunctioning transmitter that might conceivably cause harmful interference to important radio services worldwide. [Ref. 10 : p. 12-2]

The processor can be configured to provide positive control over the transmitter. However, if a failure occurs and the processor is no longer operating, this control will not be sufficient. A method must exist to secure the transmitter that does not presume the processor or HDLC hardware is operating. This method will be a function of the communication package. A unique sequence that would not normally be encountered could be assigned as a reset sequence. A sequence detector could be included in the transceiver to detect this sequence and secure the transmitter independently of the processor. This sequence must consider that transmitters may continuously send flags while idle and that a sequence of 15 '1's is used as a frame abort sequence. Responsibility for further development of the processor failed transmitter control will be left to the communication package designer. A method to secure the transmitter on failure of the receiver will be discussed in a following section.

2. Telemetry and commands

The processor will be responsible for receiving commands over the digital link and executing these commands. In addition, the processor will monitor on-board sensors, collecting and formatting telemetry messages. Command execution is mostly a function of the software. The software must be designed to recognize that an incoming packet is a command to the satellite instead of a store and forward message. The software must implement security to ensure that only authorized stations can command satellite functions. The hardware interface will be a parallel output port that can command relay drivers. Depending on the number of actuators to be driven, a multiplexer may also be required.

Telemetry data will be gathered through an analog multiplexer and analog to digital converter. Some telemetry data concerning the communications package or the

embarked experiment may be sampled in a digital format. Again, it will be a function of the software to perform data collection and to format the data into packets for transmission. The number of input channels for telemetry and output channels for command actuation is yet to be determined.

Processing power required for telemetry gathering is minimal. The processor needs only to select a multiplexer address, start analog to digital conversion, and read the results when the conversion is complete. Even if 64 channels of data (a large number for such a small satellite) are required to be sampled every five seconds, actual processor cycles required would be a small fraction of available cycles. Command execution is even easier. All that will be necessary is to output a bit or word to a parallel port to actuate a relay driver. (No capability for analog output is envisioned.)

3. Housekeeping

At present, the only housekeeping functions anticipated are control and monitoring of the battery charging system. The power system for the satellite has not been designed at present beyond specifying redundant 28 volt battery banks. Each bank may require means to independently connect or disconnect the bank from the charging system or from the power distribution bus. This implies at least four actuation channels to drive relays. Monitoring the power system will require · ..emetry inputs. These will probably include:

- voltage on each battery bank
- charging current
- power supply current draw
- regulated bus voltage

Actual monitoring and control will be determined when the power system design is finalized.

F. MEMORY

The memory system can be divided into three components. These are the fixed storage (PROM) that holds the operating system kernel, vital RAM that holds system vital data, and non-vital RAM that holds messages and telemetry data.

1. PROM storage for operating system kernel

Initial program load will be accomplished from the on-board read only memory. This is one of the vital links in the system. If the program in this PROM becomes corrupted, it may not be possible to successfully restart or reload the satellite system. A high

reliability, fuse programmed PROM will be required to ensure that this program does not become corrupted. An additional measure of reliability can be added by using two separate PROMs as was done on UoSAT-2. UoSAT-2 had a separate command channel to enable the alternate PROM. As previously determined, PANSAT will only have one communication link. The switch between PROMs cannot be commanded directly. One solution would be to have the PROMs toggle on each reset. If one fails, then two sequential resets would be required to restart on the good PROM. This would be inconvenient, but better than having a totally failed system.

Two alternatives exist for the size of the program loaded into the PROM. The preferred alternative is to have the entire satellite operating system in the PROM. In this case, a reset would completely initialize the satellite and set it up for store and forward communications. If sufficient PROM storage is not available, or the store and forward software is too complex, the PROM program could just initialize the satellite communications link to receive an uploaded program. Typical satellite PROMs vary between two and eight kilobytes of storage. The UoSAT-2 used only 512 bytes of PROM. This loaded a minimal program that enabled the processor to receive the operating program over the digital communication link [Ref. 3]. The FO-12 was unique in that it contained no read only memory.

Since the PROM will contain the bootstrap program for the processor system, software reliability is a large concern. The software burned into the PROM must remain error free. PANSAT will have the capability to be reprogrammed, but this is only possible if the communication link is properly initialized on the satellite.

2. **Vital RAM for operating system functions.**

The read-write random access memory (RAM) can be divided into two sections:

- vital RAM, in which a bit error would adversely affect system operation, possibly requiring resetting the system

- non-vital RAM, in which a bit error may corrupt a message but does not affect system operation.

A preferred system design would have all RAM implemented in radiation hardened devices and would provide error detection and correction. As previously mentioned, radiation hardened memory devices are much more expensive. Error detection and correction requires four additional bits per word for eight bit words, and five additional bits for 16 bit words. Additional hardware is required for error correction beyond the increase in storage required. While error detection and correction is a desired feature, it is not required for the relatively simple, low cost design of PANSAT. Instead, vital

memory will rely on the immunity of radiation hardened RAM to single event upsets. Eight kilobytes of storage will initially be allocated as vital RAM.

3. Non-vital RAM

Non-vital RAM will compose the bulk of processor memory. This area will include the store and forward messages and telemetry data. The size of this RAM is limited by available power, volume, and addressing capability. Within these bounds, this memory should be as large as possible. As an alternative to radiation hardening, this RAM should be sectioned, allowing the processor to disconnect a faulted section of memory from the power supply. This will allow latch-up conditions to be reset or permanent failures to be isolated to reduce impact on the total system. For maximum reliability, the processor initialization sequence could remove power from non-vital memory, then power up sections and assign addresses as needed. This would prevent a non-vital RAM failure from preventing a successful initialization.

4. Monitoring

If sufficient telemetry channels are available, the current to independent non-vital memory sections could be monitored. This would provide data on how current draw changes in memory devices with long term radiation exposure. In addition, it may provide data to analyze failure of a memory section.

G. WATCHDOG TIMER

A method was previously developed to reset the processor and exhibit control over the transmitter if the processor of HDLC protocol controller failed. However, if the receiver is the failed component, this method will not secure a malfunctioning transmitter. As an additional safeguard, a count down timer could be used to monitor processor operation. During proper operation, the processor would reset the timer count at regular intervals. If the processor exhibited a software failure, potentially placing the processor in an infinite loop and leaving the transmitter keyed, this timer would expire. Expiration of this timer would cause a software reset of the processor, reinitializing the system and securing the transmitter. The periodic timer count reset must not be an interrupt function, but a normal function of properly operating software. If it is an interrupt function, it will not break the infinite loop condition; the interrupt will return to the infinite loop after resetting the watchdog count.

H. INTERRUPT CAPABILITIES

Data transfer between the processor and HDLC formatter was previously determined to be optimally performed by processor interrupts. The analog to digital converter

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may also be designed to interrupt the processor when conversion results are available. An on-board experiment may be designed to interrupt the processor when service is required. A timer may be used to interrupt the processor when the next regular housekeeping task must be performed or telemetry data gathered. These imply that the processor must have at least five levels of interrupt with appropriate circuitry to receive and process interrupts. Typical interrupt controllers provide eight channels, providing for flexibility in interrupt design.

I. INITIAL DESIGN CONCEPT

The concepts explored in the above sections determine the desired baseline design of the PANSAT on-board processor. These functions and interfaces are illustrated in Figure 7 on page 29.
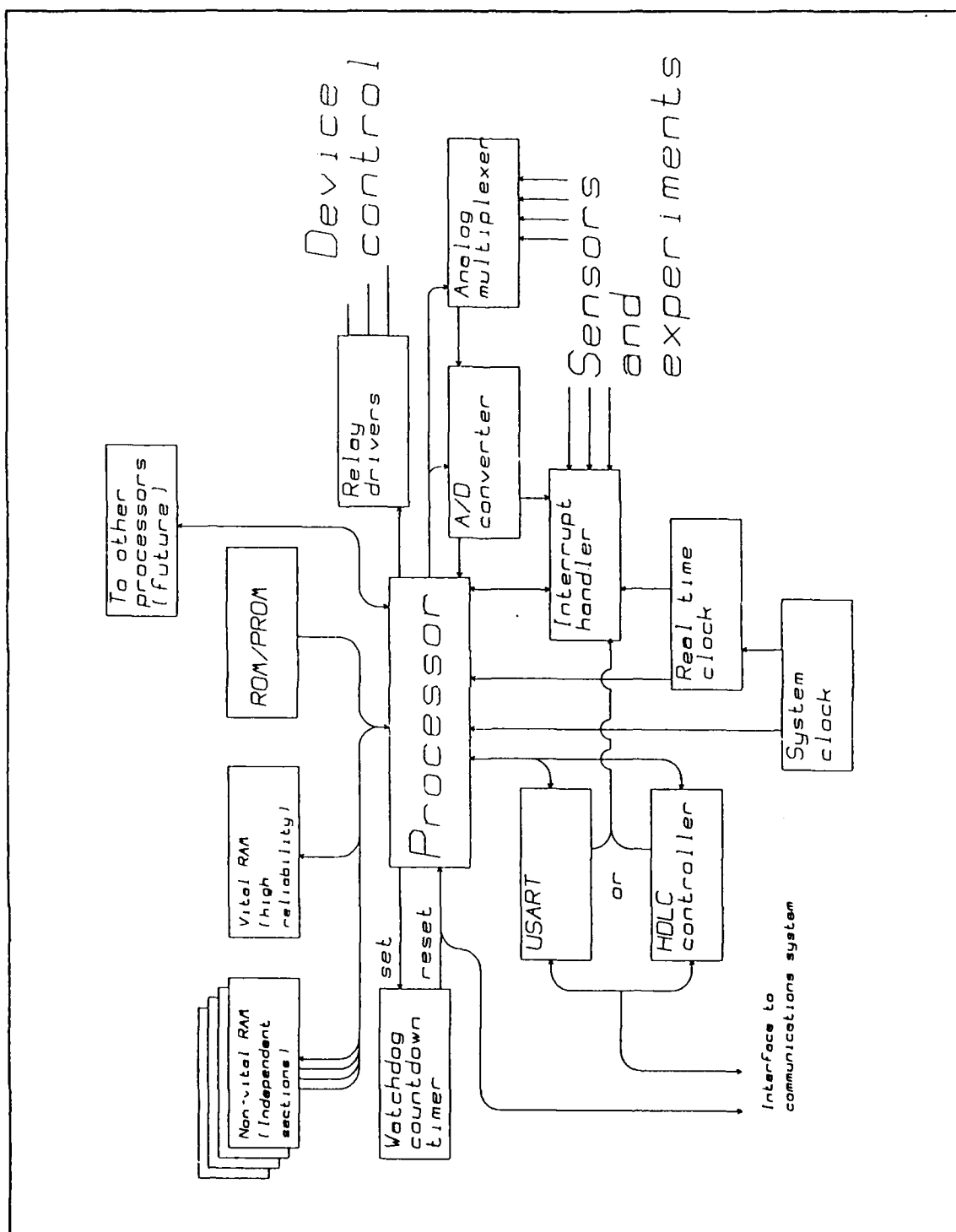
Figure 7.   PANSAT processor initial system concept

III. PROCESSOR DESIGN

A. PROCESSOR SELECTION

Current Space Systems Academic Group projects use the NSC-800 as the basis for processor systems. The current design has at least four years of operation and testing. However, a more powerful system is required to implement the store and forward message system. A previous design was attempted with an 8085. This processor did not have high enough throughput for even the simpler requirements of previous experiments.

The microcontrollers (MC68HC11 and 8096) offer interesting possibilities for space based control applications. They contain a processor, RAM, ROM, clock, reset circuit, watchdog timer, interrupt circuit, programmable timer, serial port, several parallel ports, and an A D converter, all within a single chip. The disadvantage of using a microcontroller is that on chip memory is limited and addressing memory off chip is clumsy. Additionally, read only memory is implemented in EPROM which is not suitable for higher radiation environments experienced in space. Procuring a chip with ROM instead of EPROM requires mask charges and large orders; otherwise unit costs are high. This eliminates the microcontrollers from consideration.

The 8086 and MC68000 are both sophisticated, medium performance microprocessors. The advantages of the MC68000 are:

- the data bus and address lines are not multiplexed (as in the 8086)
- memory and I O interface is simplified through use of DTACK protocol,
- the address bus uses 24 bits (versus 20 in the 8086), and
- peripherals are mapped into memory, simplifying I O data transfer.

The advantages of the 8086 are:

- a full family of CMOS products exists, including commercial, industrial, high reliability, and radiation hardened. This allows initial design in low cost components with the more expensive components used in the final implementation.
- A large number of software development tools are available.
- Software presently exists that implements the store and forward protocol.
- Other satellites have been constructed based on the 8086, thereby establishing a history of reliable space operation.

Based on the 8086 advantages, an 8086 system will be designed. The specific processor targeted is the Harris 80C86RH, a radiation hardened, CMOS version of the 8086.

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B. PROCESSOR MODE SELECTION

The 80C86RH can operate in either minimum or maximum mode. In maximum mode bus control signals are multiplexed on three pins: S0*, S1*, and S2*. (The * is used to indicate an active low signal.) These signals are used by the 82C88 bus controller to synchronize bus operations and to allow for more than one bus master. Since the maximum mode requires an additional chip and since the flexibility of having more than one processor access the bus is not required, the minimum mode will be used. Minimum mode is selected by tying MN MX* to Vdd.

In minimum mode, the 80C86RH directly generates signals necessary to control read or write to memory or peripheral devices. These signals are RD*, WR*, and M IO*. RD* is active for reading from devices. WR* is active when writing to devices. M IO* is high when accessing memory address space and low when accessing IO (or peripheral) address space. The 80C86RH data bus is 16 bits wide, but it can access individual byte items. The processor uses A0 and BHE* to indicate whether an action affects a byte or a whole word. The effect of these signals is shown in Table 6 [Ref. 11: p. B-8]. When a byte operation is performed, the bus interface unit inside the 80C86RH automatically routes the byte from the high or low half of the data bus to the proper internal register.

Table 6. BYTE SELECTION CONTROL

BHE*	A0	Bytes accessed
0	0	Whole word
0	1	Upper byte to from odd address
1	0	Lower byte to from even address
1	1	None

In either mode of operation, address and data information are time multiplexed onto the same bus. The 80C86RH bus cycle consists of four clock periods. These are labeled T1 through T4. (In some cases, wait states are inserted between T3 and T4. These are indicated by Tw.) During T1, the processor provides the selected address on A0-A19. During the remaining periods, the processor will read data from or write data to A0-A15 while A16-A19 provide status and control for maximum mode system. Address and data information must be demultiplexed from A0-A19 external to the 80C86RH. In minimum mode, the processor generates ALE, DEN*, and DT/R* to control demultiplexing. Two methods of demultiplexing are available. The first method uses synchronous

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memory devices designed to operate directly with the 80C86RII. These memory devices have internal latches to hold the address during decoding and memory access. One such device is the Harris 92560 64 kilobyte by 8 bit synchronous RAM module. Using synchronous modules presents several limitations. A limited selection of devices is available. These devices are not pin compatible with standard 28 pin memory devices. Inability to acquire the exact device that the system is designed to use may force a re-design. These synchronous RAM modules are not typically available in radiation hardened or high reliability versions. In addition, unless synchronous decoders are used, the upper address bits, A0, and BHE* must still be latched externally for chip select decoding. Most 80C86RH peripheral devices are not synchronous so address bits used by peripherals must also be latched. Last, the drive capability of the 80C86RH outputs is limited, so an external bus driver may still be required. With these disadvantages, a synchronous system using the multiplexed bus is not the solution for PANSAT.

The second demultiplexing method uses external latches. These latches are loaded with an address during T1. They then maintain a stable address throughout the entire bus cycle. Since PANSAT will be a multiple board system, two additional options exist. These are demultiplexing the buses on the main board and distributing demultiplexed data, or distributing the multiplexed bus and providing address latches on each board for local demultiplexing. Since the circuit boards will be separated by several inches at most, and the PANSAT design is to be simple, only one set of address latches will be used and the demultiplexed bus distributed to the secondary boards.

The 80C86RH is rated to operate from DC up to five MHz. (Since the circuit is CMOS and does not use dynamic storage, the clock can be stopped without loss of status. This is different from the initial 8086 which used dynamic storage and had a minimum clock frequency of two MHz.) At maximum rated frequency the processor requires a 33 percent duty cycle clock. The clock must be active (high) for 33 percent of the clock period; this is to ensure that the clock inactive time is at least 118.6 nanoseconds. If a frequency less than 4.2 MHz is selected, a symmetric clock may be used. In this design, a five MHz clock will be assumed. This gives a clock period of 200 nanoseconds and a bus cycle time (with no wait states) of 800 nanoseconds. This timing is conservative by current device standards and will allow wide flexibility in choosing memory and peripheral devices.

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C. BUS DEMULTIPLEXING

A typical minimum system, shown in Figure 8 on page 34, uses three 82C82 octal latching bus drivers to demultiplex the address bus and two 82C08RH bus transceivers to drive the data bus. These circuits are not appropriate for PANSAT. The 82C82 is not available in a radiation hardened version. This is solved by substituting three 54HC573 octal latches in place of the 82C82s. The 54HC573s are functionally identical to the 82C82s and are available in high reliability versions. The timing of the 82C08 is marginal for the system. System timing using the 82C08 in a synchronous design with 92560 synchronous RAM modules is shown in Figure 9 on page 35. The worst case timing is shown. DEN* goes active 110 nanoseconds after the rising edge of T2. This activates the 82C08 output which has a 130 nanosecond delay until the output is valid. As shown, this will present data to the 80C86RH exactly at the setup time with no margin. To use the 82C08 reliably, the system must be slowed. As an alternative to slowing the system, the 82C08s can be replaced by 54HC245 transceivers. These are functionally identical to the 82C08s but have only a 30 nanosecond delay from enable to output.

The data bus transceivers are not required for system bus demultiplexing as this was accomplished by the address latches. They serve two other purposes. First, they increase the output drive of the 80C86RH and provide isolation of data bus components from the processor. Second, they reduce bus contention by isolating the data bus from the address bus during T1 while the processor is outputting an address.

Three 54HC573s are required to latch a 20 bit address plus BHE*. Latching the address is controlled by ALE. The latch outputs are permanently enabled by tying output enable (OE*) to ground. The 80C86RH does not provide a signal that could be directly used to enable address latch output only when a valid address exists. Therefore, the address latch output will be permanently enabled. Permanently enabling these outputs will not cause contention on the demultiplexed address bus as the 80C86RH is the only source of an address.

Two 54HC245s are required to drive a 16 bit data bus. Direction of transfer is controlled by DT/R*. The output enable (OE*) of the 54HC245s is controlled by DEN* from the 80C86RH. This signal is active only during T2, T3, and T4, after the address output has been latched and the multiplexed system bus is ready for data transfer. Operation of DT/R*, DEN*, and 54HC245 direction of transfer is shown in Table 7 on page 34.
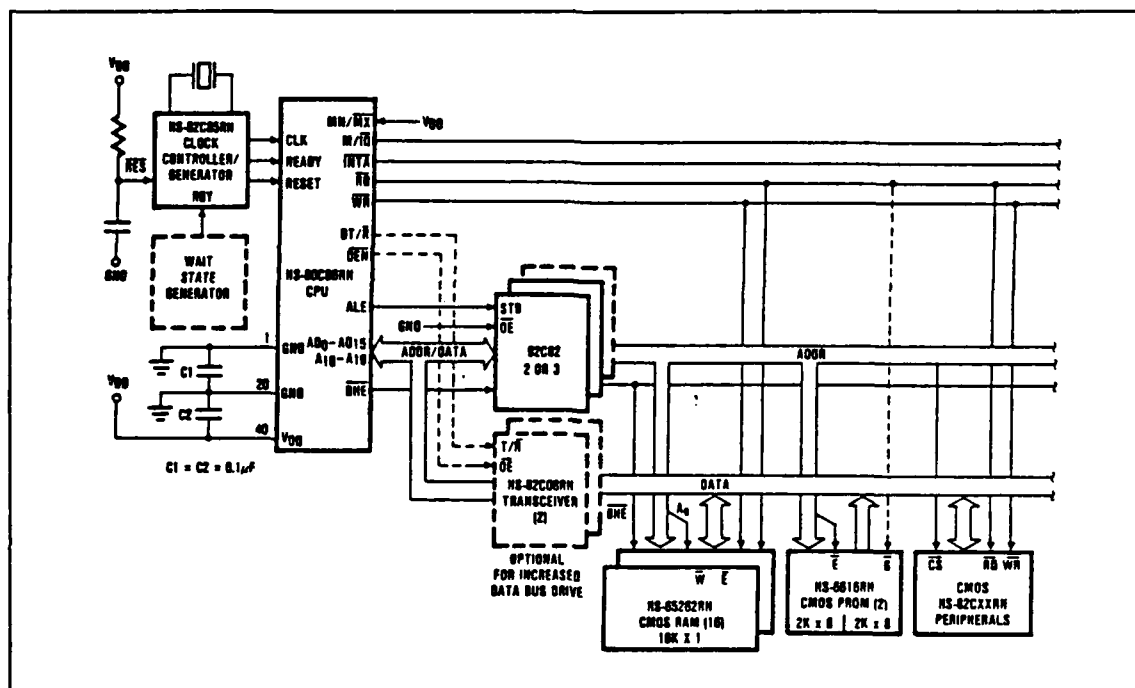
Figure 8. Minimum mode HS-80C86RH typical configuration: [Ref. 6, p. 4-65]

Table 7. DT/R* AND DEN* CONTROL OF 54HC245

DEN* (EN*)	DT/R* (A → B)	data direction	54HC245 function
0	0	read data (to processor)	B to A
0	1	write data (from processor)	A to B
1	X	none	high impedance

The interconnection of the 80C86RH, 54HC245s, and 54HC573s are shown in Figure 10 on page 36. (The symbol for pin 1 of the 54HC245 may be confusing as it indicates $A \rightarrow B$ is an active low signal. In fact, this signal behaves as shown in Table 7 on page 34.) In this and all following circuit schematics the following signal names are used:

- AD0 through AD19 for the multiplexed system bus,
- BD0 through BD15 for the demultiplexed (buffered) data bus, and
- BA0 through BA19 and BBHE* for the demultiplexed (buffered) address bus.

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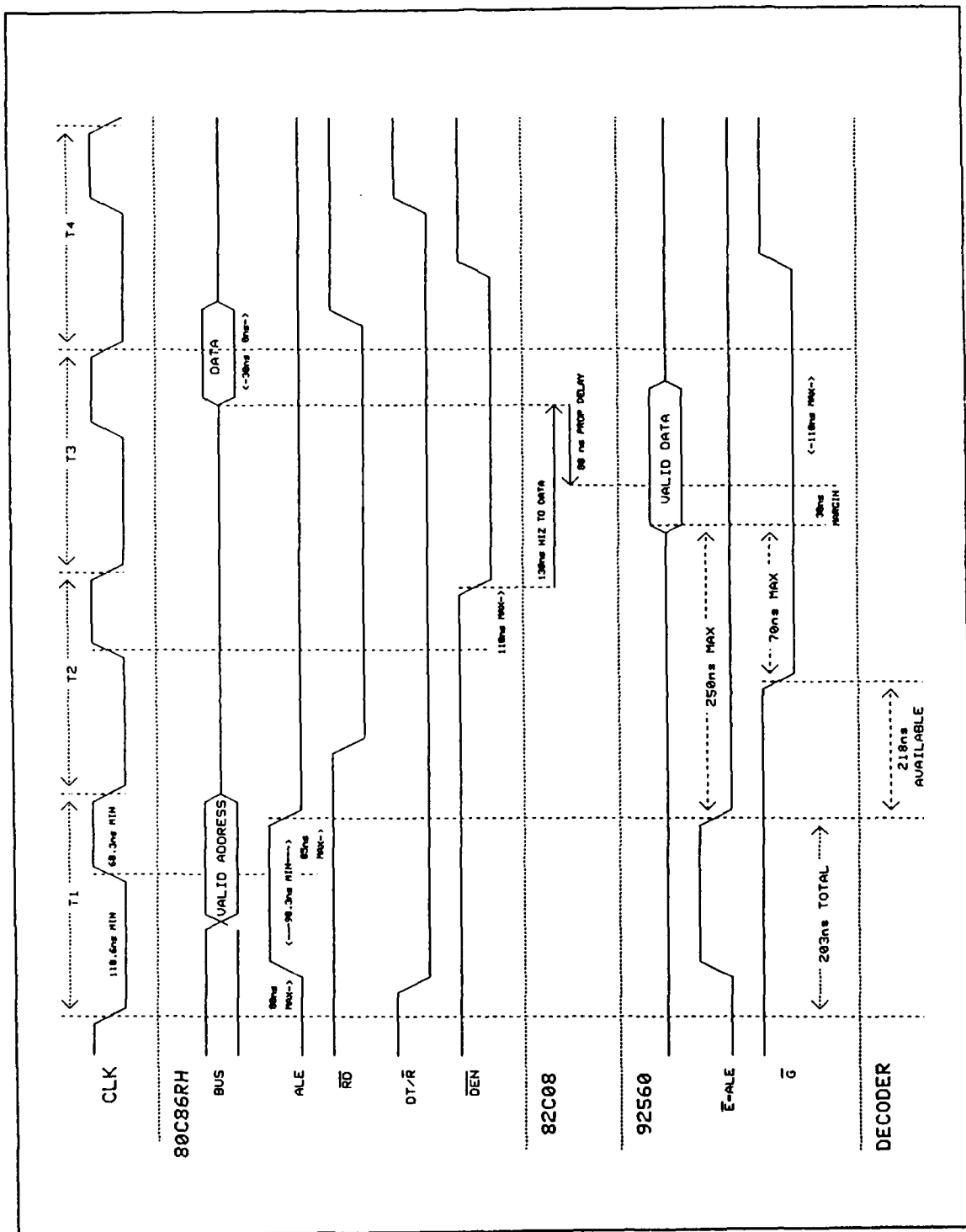
Figure 9.   System timing using 82C08 bus tranceivers

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Figure 10. Pansat processor main board

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D. OTHER PROCESSOR CONNECTIONS

The 80C86RH TEST* pin operates with the 80C86RH WAIT instruction. A WAIT instruction will cause the processor to idle while testing the TEST* input. When the TEST* input goes active, processor activity will resume. This pin could be connected to a timer output to allow the processor to run idle cycles for a predetermined time. However, this method of synchronization could lead to an infinite loop if the timer was improperly initialized. Synchronization with external devices such as telemetry collection or an embarked experiment is better accomplished through an interrupt structure. The TEST* input is connected to ground (permanently active) so a WAIT instruction will have no effect.

The HOLD input allows another processor to access the local bus. When HOLD is active, the 80C86RH will place the system bus and control lines in a high impedance state until HOLD goes inactive. This feature is not desired and HOLD is made permanently inactive by tying to ground. HLDA is an output acknowledging HOLD and has no connection. (Figure 10 on page 36 shows HOLD as RQ*/GT0* and HLDA as RQ*/GT1*. These are the maximum mode pin definitions.)

E. CLOCK GENERATION

To operate the 80C86RH at the maximum rated speed of five MHz requires an assymetric, 33 percent duty cycle clock. This can be generated by the 82C85RH clock generator circuit. The 82C85RH requires a frequency source operating at three times the desired clock frequency. This can be generated by placing a 15 MHz parallel resonant, fundamental mode crystal across X1 and X2 and tying F/C* low (to select internal frequency source). To ensure stable oscillator operation, two capacitors are added such that their combined capacitance ($\frac{C1 \times C2}{C1 + C2}$) matches the load capacitance required for the crystal [Ref. 6: p. 4-143]. The values for these capacitors will be determined when the actual crystal is obtained. The required 33 percent duty cycle clock is available on CLK and may be connected directly to the 80C86RH CLK input.

In addition to clock generation, the 82C85RH also provides:

- power on reset generation using a Schmidt trigger,
- clock start/stop and slow/fast control,
- two separate ready and ready qualification inputs,
- a 50 percent duty cycle clock, and
- a peripheral clock operating at one sixth the crystal frequency.

The start stop control requires an 82C88 bus controller or discrete circuitry to decode the halt command on S0*, S1*, and S2*. In addition, once the clock is stopped an external event (interrupt) is required to restart the clock. To prevent a HALT command from stopping the clock without external means to restart the clock, this start stop capability will not be used in this design. The start command will be permanently enabled by tying START to Vdd.

The Schmidt trigger reset circuit generates the required width reset pulse for the system. The minimum high voltage on the reset input is 2.8 volts. An external resistor-capacitor (RC) network must be added to keep the 82C85RH reset input below 2.8 volts until the power supply stabilizes at five volts, then allow this input to increase. The capacitor voltage is given by:

$$Vc(t) = V\left(1 - e^{-\frac{t}{RC}}\right) \tag{4}$$

where V is the power supply voltage and t is time. The value of RC depends on power supply characteristics and will be determined when power supply design is complete. A communications system reset output will also be connected to the 82C85RH reset input. Due to the external pullup resistor, this second input should be connected through an open collector output stage.

Ready generation will be examined with peripheral and memory design. The remaining 82C88RH functions will not be used. The 80C85RH connections are shown in Figure 10 on page 36.

F. 80C86RH PERIPHERALS

Peripheral devices supporting the 80C86RH may be addressed by one of two methods. They can be mapped into the 2^{20} address memory space or into a separate 2^{16} address I/O space. The advantage of mapping into the memory space is that all memory operations, such as MOV, PUSH, and POP, may be directly applied to peripheral devices. However, the 80C86RH cannot directly move from one memory location to another. This requires two separate bus operations and two separate instructions. If mapped to the I/O space, all transfers must go through register AX or AL using the IN or OUT instructions. Since both methods require two instructions and two bus cycles to transfer a byte from memory, the only advantage to mapping peripherals into the memory address space is the ability to use any register to temporarily hold the transferred byte. If memory mapping is used, some portion of address space is lost. In certain

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instances, the IN and OUT instructions are faster than memory instructions. For these reasons, PANSAT processor peripherals will be mapped to the I O space. Chip select for peripheral devices will be considered after addressing requirements for all peripheral devices are examined.

The peripherals required for the system depend on the functions desired. PANSAT will require the following peripherals:

- Analog to digital converter,

- parallel input output ports for device control,

- interrupt controller (since the 80C86RH will only recognize two levels of interrupt without external circuitry),

- a timer circuit(s) for the watchdog timer, and

- an HDLC protocol controller.

The selection and connection of these items is described below.

1. Analog to digital converter

The analog to digital converter will receive analog signals through a series of multiplexers and provide a digital output to the processor. Typically eight bit accuracy would suffice for PANSAT purposes. However, the ideal choice for the PANSAT is the Intersil ICL7115. This is available in CMOS and provides 14 bits of accuracy. In addition, interface to the 80C86RH is simplified as it will directly map to the I O space and recognize processor signals for control. WR* will initiate a conversion cycle and RD* will allow the processor to read the results.

The ICL7115 will perform 14 bit conversions in 40 microseconds using a 500 kHz clock. Rather than add a 500 kHz crystal to the circuit (crystal connections are available on the ICL7115), the system clock is divided below 500 kHz to provide the conversion clock. Proper system operation will then rely on only one clock rather than two clocks. The 82C85 50 percent duty cycle clock (operating at five MHz) is used to clock a 54HC161 binary counter. The QD output then provides a clock that is 1 16th the input frequency, or 312.5 kHz. This provides a conversion time of 64 microseconds. (The 54HC161 connections to implement a divide by 16 counter are shown in Figure 10 on page 36.) This 312.5 kHz clock is connected to the OSC2 input of the ICL7115.

The ICL7115 provides 14 bits of output plus an over-range flag. The output bits are connected to BD0-BD13 while the over-range flag is connected to BD14. This allows a single word transfer (such as: IN address,AL) to read conversion results. On occasion,

the programmer may wish to load only the low or high byte of the conversion. This is controlled by the A0 and BUS pins of the ICL7115. These are connected to BA1 and BA2 to perform this selection. BA0 cannot be used for this selection as it indicates whether the low or high byte of the data bus is to be read by the 80C86RH processor. In the ICL7115, selection of low or high byte routes the selected byte to the low byte of the data bus. Therefore A0 must be low (0) to read the low byte of the data bus. Table 8 summarizes the control of the ICL7115.

Table 8. ICL7115 CONTROL

WR*	RD*	BUS (BA2)	A0 (BA1)	Action
0	X	X	X	Initiate conversion
X	0	0	0	low byte to BD0-BD7 (A0=0)
X	0	0	1	high byte to BD0-BD7 (A0=0)
X	0	1	X	both bytes to BD0-BD14 (A0.BHE* = 0)
X	1	X	X	high impedance output

The analog signal is input on Vinf. Vins provides an output of the voltage sensed by the ICL7115. This can be used to drive an op amp to restore any voltage drop in sensing lines. Similar arrangements are possible on the reference voltage and analog ground inputs. Due to the small size of PANSAT, these op amps will probably not be necessary and are shown as optional in Figure 11 on page 42. When the telemetry system design is finalized, the telemetry designer will determine the need for these op amps. The VREF input should go to the best regulated high voltage on-board PANSAT to provide a stable reference. (All conversions are referenced as a percentage of this voltage.)

The analog voltage input to the ICL7115 is selected by two levels of 54HC4051 analog multiplexers providing 36 telemetry input channels. Up to four additional 54HC4051s may be added to increase input to 64 channels while maintaining only two level multiplexing. The primary 54HC4051 is controlled by four bits of a parallel output port, with one bit enabling output and three bits selecting the input channel. The second level multiplexers are similarly controlled as a group by the remaining four bits of the parallel port.

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The ICL7115 indicates conversion is complete by a high level on EOC. This can be used to cause an interrupt request for the 80C86RH to read the conversion value and initiate the next conversion. The ICL7115 and 54HC4051 connections are shown in Figure 11 on page 42. Specifications for the ICL7115 are found in reference 12.

2. Parallel input/output port

The PANSAT processor requires a parallel output capability to control the telemetry multiplexers and other device on/off control. The 82C55RH provides three bidirectional eight bit ports that can be used for this purpose. Since the 80C55RH is an eight bit device, it is connected to only the lower eight bits of the data bus (BD0-BD7). The 80C55RH has four internal registers, selected by A0 and A1. However, the 80C55RH A0 cannot be connected to BA0. BA0 selects the low byte for a transfer, and if BA0 equaled 1 to control 80C55RH register selection, this would disable transfer from the low eight bits of the data bus. Therefore A0 is connected to BA1 and A1 to BA2. The operation of these signals is summarized in Table 9.

Table 9.   80C55RH REGISTER SELECTION

A1 (BA2)	A0 (BA1)	Register selected
0	0	port A
0	1	port B
1	0	port C
1	1	control word

RD* is connected to the system read signal and WR* is connected to the system write signal. These signals determine whether a control or output word is to be written to or read from the 82C55RH. The 82C55RH RESET input is connected to the system reset signal generated by the 82C85RH. The chip select input will be considered later.

The 82C55RH has three operating modes with multiple submodes. In the PANSAT processor, only simple output is required. This is mode zero. All three ports are configured for output by writing 10000000b (128h) to the control word. Port A is connected to the multiplexing system for the ICL7115. The control effect of these connections is summarized in Figure 12 on page 43.

The parallel port also implements device control through port C. Port C was selected for this control since individual bits of port C can be set or reset with a special control word. This allows changing status of one device without causing a glitch in the
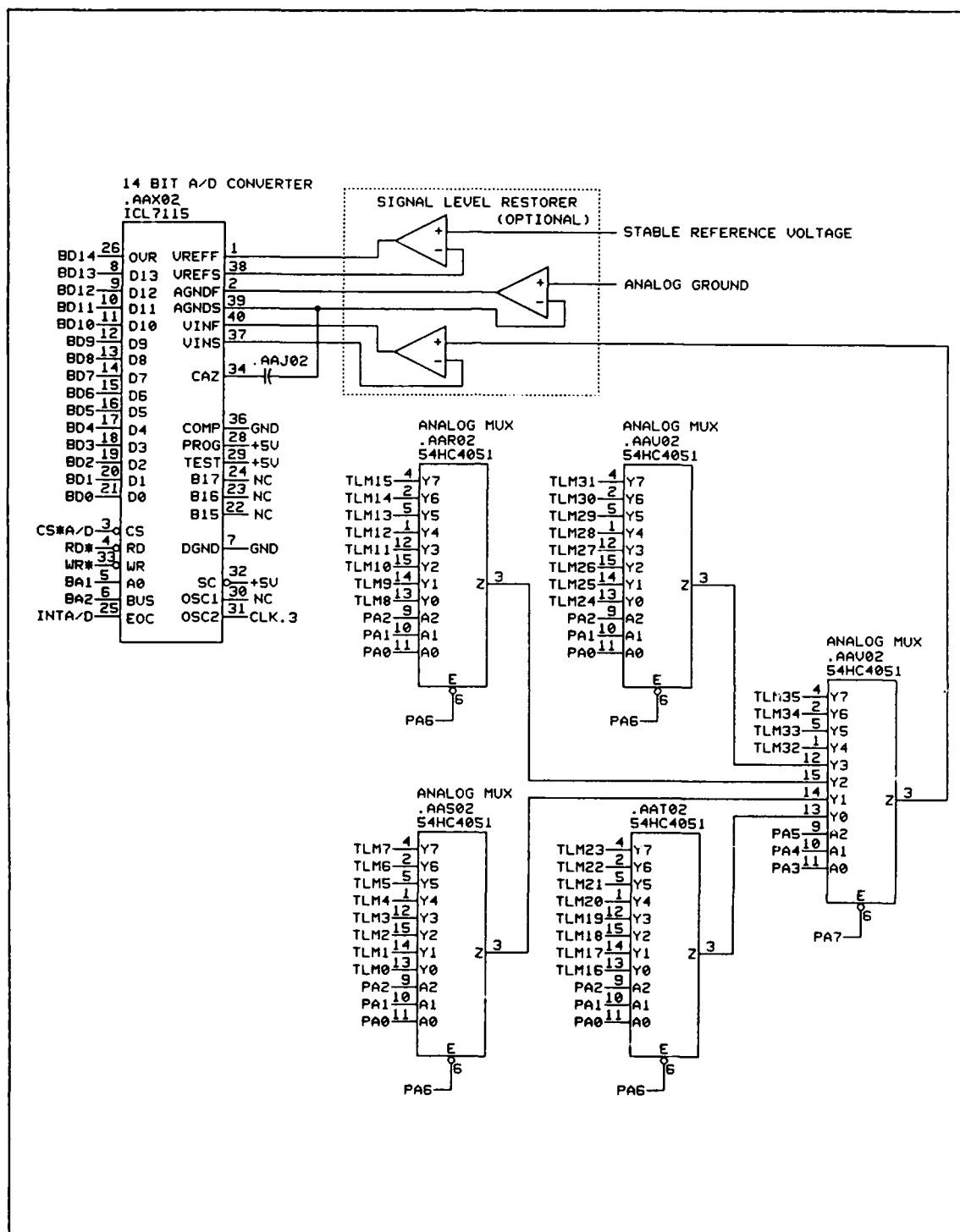
Figure 11.   PANSAT processor telemetry section

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PRIMARY MULTIPLEXER ENABLE	SECONDARY MULTIPLEXERS' ENABLE	PRIMARY MULTIPLEXER		CHANNEL	SECONDARY MULTIPLEXERS'		CHANNEL
BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0

THIS CONTROL WORD IS WRITTEN TO PORT A TO CONTROL ICL7115 MULTIPLEXER INPUTS.
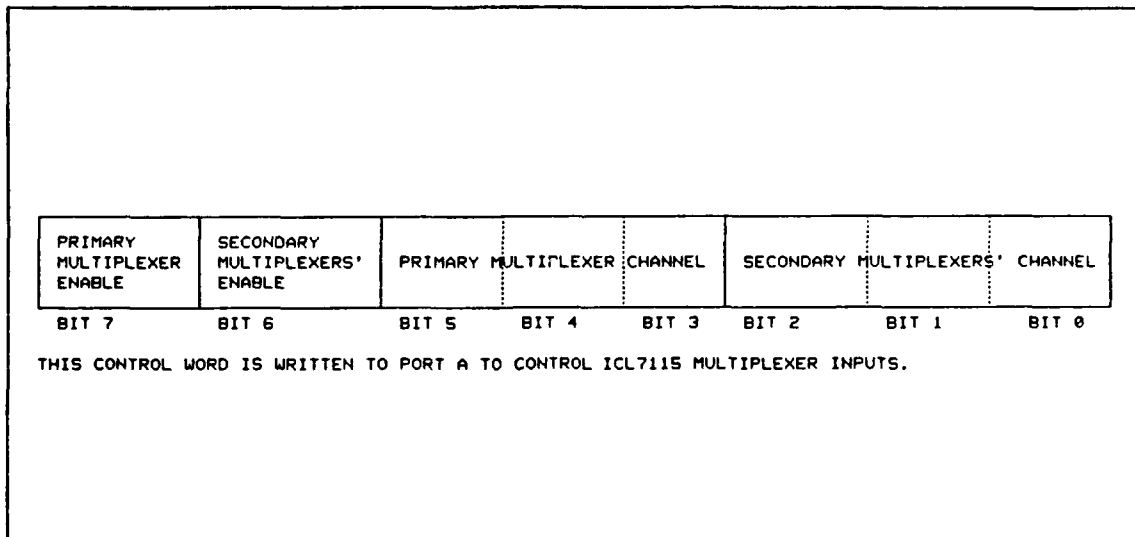
Figure 12.   ICL7115 input channel selection

status of another device. This control word is shown in Figure 13 on page 44. Two 54HC4016 quad bilateral switches are used to provide eight channels of digital control.

When the 82C55RH is reset, all ports are set to input mode with input pins pulled up to Vdd. To have this condition disable all devices controlled through the 54HC4016s, the port C outputs are connected to the 54HC4016s through inverters. Since the 82C55RH outputs are latched internally, an external latch is not required. If more than eight channels of control are required, port C could be used to drive two 54HC259 eight bit addressable latches, each driving two 54HC4016s. This will provide sixteen channels of control. As an alternative, port B could also be used to drive two 54HC4016s. However, port B is not bit addressable and may not provide glitch free control. At present, port B is reserved for future use. Figure 14 on page 46 shows the 82C85ARH connections.

3. HDLC protocol controller

The need for an HDLC controller to format the packet communications was analyzed previously. The 8273 HDLC controller can be mapped directly into the I/O space like other peripherals. Like the 82C55RH, the 8273 is an eight bit device. This implies the same limitations on using BA0 as an address input. The data bus connections, RD*, WR*, and RESET connections are similar to the 82C55RH. The previous analysis showed that an interrupt driven HDLC controller would be sufficient for the PANSAT processor. The 8273 is therefore connected for interrupt driven control.

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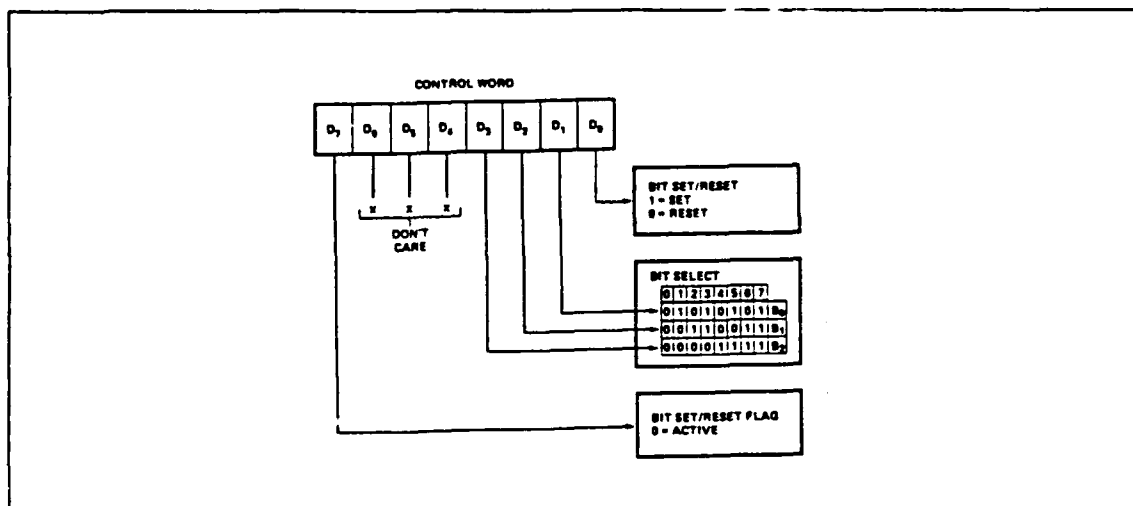
Figure 13. Bit set/reset control word format: [Ref. 6, p. 4-120]

Two of the four DMA controls are still used to control register access. The others (TxDRQ and RxDRQ) are unused. The 8273 A0, A1, TxDACK*, and RxDACK* connections are used with RD* and WR* to access the nine internal registers. TxDACK* selects the transmit data register; RxDACK* selects the receive data register. Since the 8273 is designed to operate with a DMA controller, TxDACK* and RxDACK* do not require CS* to be active to select these registers. Therefore, address lines cannot be used to control TxDACK* and RxDACK* as this may result in erroneous data transfers. These two signals will be generated separately by the chip select decoder to prevent inadvertent data transmission or bus contention.

The remaining 8273 registers are accessed only when CS* is active. These registers may be controlled by BA2 and BA1 connected to A1 and A0 respectively. (As previously discussed, the system BA0 is not used to control register select in eight bit peripherals.) The result of these configuration is that the 8273 uses three peripheral chip selects. One is used to control TxDACK*, one is used to control RxDACK*, and one for the 8273 chip select (and remaining registers). A summary of these signals is shown in Table 10 on page 47. The connection of TxDACK* and RxDACK* will cause the registers controlled by these signals to be addressed as separate I/O devices.

FLAGDET* is connected to the interrupt controller to provide the capability for interrupting the processor when the 8273 detects a valid flag. The remaining connections go to the communication package. The 8273 provides sophisticated modem interface and control capability. This capability is detailed in Reference 13 (pp. 8-163 to

8-187). The connections required and 8273 operating mode desired will be determined when the communication package design is finalized.

The 8273 HDLC controller does present one disadvantage; it is not available in a CMOS version (as of February, 1989). The TTL version consumes one watt of power. This would be a significant fraction of the processor power budget. There are several solutions to overcome this disadvantage:

- implement the DLC protocol in software and replace the 8273 with a USART,
- implement the DLC protocol in discrete CMOS hardware as done in FO-12.
- use one of the 54HC4016 channels to power down the 8273 when not in use, or
- use a simpler, byte serial protocol.

The disadvantage of software implementation of a bit serial protocol was discussed previously. Using a protocol other than AX.25 defeats one of the main purposes of PANSAT. This leaves only the second and third options, of which the third is preferred. The effect of powering down the 8273 in an active circuit will have to be tested when the breadboard design is completed. A discrete HDLC implementation for PANSAT is a complex problem, possibly presenting another thesis topic.

If the 8273 is powered down, a method is needed to signal the 80C86RH when to power up and initialize the 8273. The carrier detect line (CD*) from the communication package can be used to provide an interrupt to start this sequence. The 8273 connections are shown in Figure 14 on page 46.

4. Timer

Implementation of the watchdog timer function requires a timer that will interrupt the processor and cause the processor to reinitialize if this timer is not reset before the timer count ends. This function can be accomplished by using a 82C54RH programmable interval timer. The 82C54RH provides three timer channels that can be used for multiple purposes. The counters have multiple modes (detailed in reference 6, pp. 4-100 to 4-115) but the only mode needed is mode zero, interrupt on terminal count. The timer two output is connected to the non-maskable interrupt (NMI) of the 82C86RH to provide the watchdog timer function. The remaining counters (one and zero) are used to provide interrupts for other functions, such as implementing a real time clock. Since one possible operating mode is a programmable rate generator, one of these timers could be programmed to generate the 500 kHz (or slower) clock for the ICL7115. This introduces another possible failure mode for A D conversion: the 82C54RH must be operating and programmed properly for successful conversion. It is preferable to use the

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PARALLEL PORT
.AAX03
82C55

BD7 27 D7   PA7 37 PA7
BD6 28 D6   PA6 38 PA6
BD5 29 D5   PA5 39 PA5
BD4 30 D4   PA4 40 PA4
BD3 31 D3   PA3 1 PA3
BD2 32 D2   PA2 2 PA2
BD1 33 D1   PA1 3 PA1
BD0 34 D0   PA0 4 PA0

PC7 10
PC6 11
PC5 12
PC4 13

PC3 17
PC2 16
PC1 15
PC0 14

PB7 25
PB6 24
RD* 5 RD   PB5 23
WR* 36 WR   PB4 22
BA2 8 A1   PB3 21
BA1 9 A0   PB2 20
RESET 35 RST PB1 19
CS*PP1 6 CS PB0 18

T L M   C O N T R O L
CHANNEL

ON/OFF CONTROL

.AAM03
54HC04
1 >o 2

.AAN03
54HC04
1 >o 2

.AAP03
54HC04
1 >o 2

.AAQ03
54HC04
1 >o 2

.AAU03
54HC04
1 >o 2

.AAR03
54HC04
1 >o 2

.AAS03
54HC04
1 >o 2

.AAT03
54HC04
1 >o 2

.AAF03
54HC4016
13 E0
SCA8 1 Y0   Z0 2 SCB8
5 E1
SCA7 4 Y1   Z1 3 SCB7
6 E2
SCA6 8 Y2   Z2 9 SCB6
12 E3
SCA5 11 Y3   Z3 10 SCB5

.AAV03
54HC4016
13 E0
SCA4 1 Y0   Z0 2 SCB4
5 E1
SCA3 4 Y1   Z1 3 SCB3
6 E2
SCA2 8 Y2   Z2 9 SCB2
12 E3
SCA1 11 Y3   Z3 10 SCB1

HDLC CONTROLLER
.AAE03
8273

BD0 12 DB0   PA4 34
BD1 13 DB1   PA3 33
BD2 14 DB2   PA2 32
BD3 15 DB3   PB4 39
BD4 16 DB4   PB3 38
BD5 17 DB5   PB2 37
BD6 18 DB6   PB1 36
BD7 19 DB7

TxINT 2 TxINT   RTS 35
RxINT 11 RxINT   CTS 30
                 CD 31
NC 6 TxDRQ   DPLL 23
NC 8 RxDRQ   TxD 29
TxDACK* 5 TxDACK TxC 28
RxDACK* 7 RxDACK RxD 26
                 RxC 27
3 CLK
25 32xCLK
RD* 9 RD
WR* 10 WR   FLAGDET 1 FLAGDET*
CS*DLC 24 CS   A1 22 BA2
RESET 4 RESET   A0 21 BA1

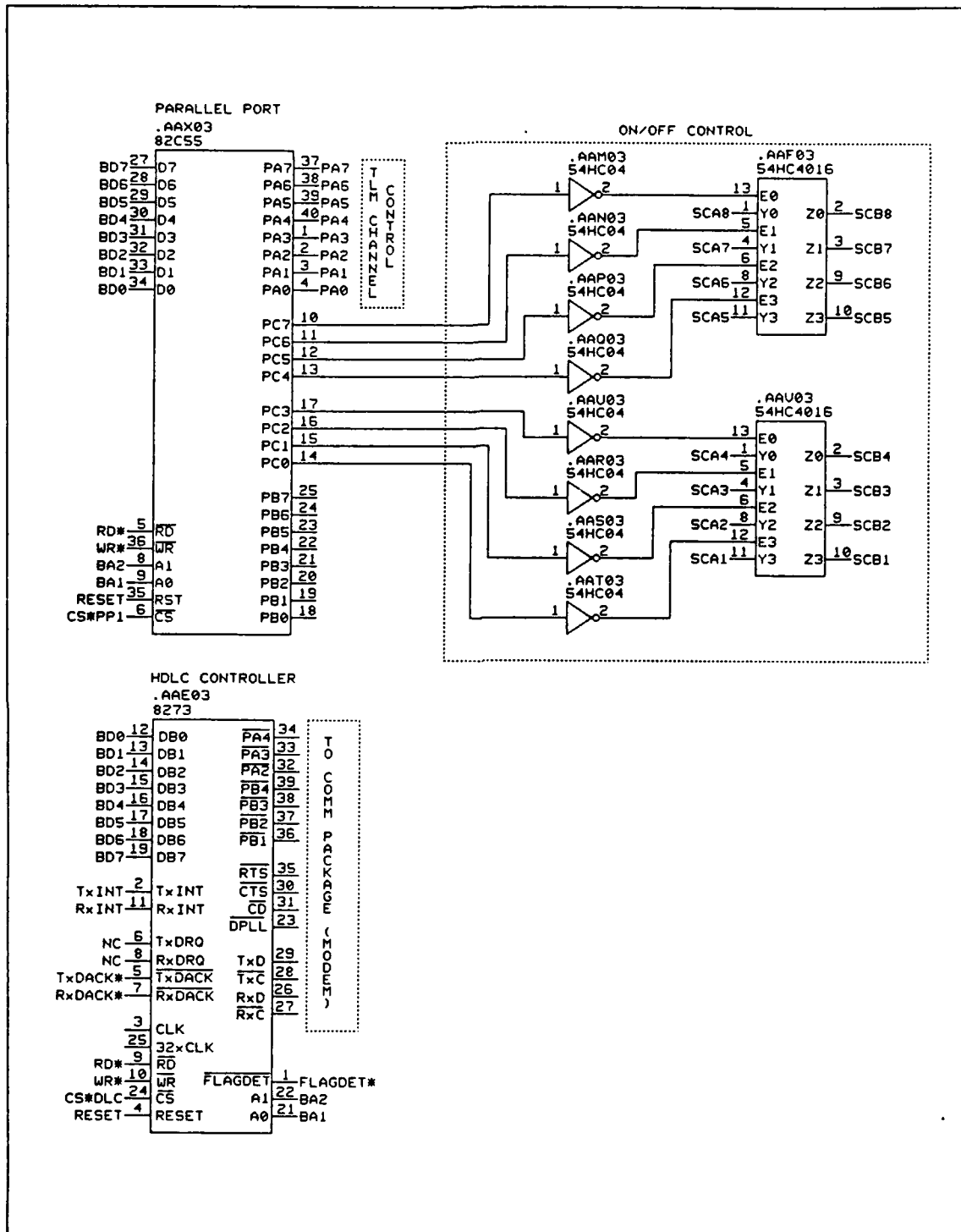T O   C O M M   P A C K A G E   (M O D E M)

Figure 14.   HDLC, parallel interface, and device control

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Table 10.   8273 REGISTER CONTROL

TxDACK*	RxDACK*	A1 (BA2)	A0 (BA1)	RD*	WR*	Register (action)
1	1	0	0	1	0	Command
1	1	0	0	0	1	Status
1	1	0	1	1	0	Parameter
1	1	0	1	0	1	Result
1	1	1	0	1	0	(reset)
1	1	1	0	0	1	TxINT result
1	1	1	1	1	0	(none)
1	1	1	1	0	1	RxINT result
0	1	X	X	1	0	Transmit data
1	0	X	X	0	1	Receive data

simpler (hence more reliable) 54HC161 divide by 16 circuit to reduce the five MHz clock below 500 kHz.

The 82C54RH timers are 16 bit timers without prescaling. (The clock frequency is not divided before decrementing the count.) If the timers operated at the full five MHz system clock frequency, the maximum delay possible would be 13.11 milliseconds. However, a 312.5 kHz clock is available from the 54HC161. Using this to drive the 82C54RH timers allows a maximum delay of 209.7 milliseconds. If the watchdog timer were set to interrupt every 0.2 seconds if not properly reset, this would allow 100,000 processor instructions (assuming 10 clock periods per instruction) between interruptions.

If required by an on-board experiment, one of the remaining timers could be reconfigured as an event counter or programmable pulse generator. This would have required breaking the GATE and CLK connections, shown in Figure 10 on page 36, and reconnecting these as required by the experiment.

The 82C54RH inputs A1 and A0 determine which of the four internal registers is selected for reading or writing. As in previous devices, the 82C54RH is an eight bit device connected to the lower half of the data bus. Therefore, BA1 and BA2 are used to control register selection. RD* and WR* control the transfer direction. The effect of these signals is shown in Table 11 on page 48.

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Table 11.   82C54RH REGISTER SELECTION

A1 (BA2)	A0 (BA1)	Register
0	0	counter 0
0	1	counter 1
1	0	counter 2
1	1	control word

5.   Interrupt controller

Several different levels of interrupt control have been identified. However, the 80C86RH has only two interrupt inputs, NMI and INT. NMI is already dedicated to the watchdog timer. To manage the remaining interrupts, an 82C59RH interrupt controller is used. The interrupts are initially prioritized as shown in Table 12 on page 48, but may be rotated or masked by the programmer. SP*/EN* is a dual function pin. As an input, it designates whether the 82C59RH is a slave or master. It can also be used as an output to control data buffers. In this implementation, it is connected to Vdd to program the 82C59RH as a master. The programmer must then select the non-buffered mode in initialization command word four. Programming details are contained in Reference 14, pp. 3-133 to 3-146. The 82C59RH connections are shown in Figure 10 on page 36.

Table 12.   82C59RH INITIAL INTERRUPT PRIORITIES

Priority	Number	Device
Highest	0	unused
	1	carrier detect (from communications package)
	2	82C54RH timer zero
	3	8273 TxINT (transmitter interrupt)
	4	8273 RxINT (receiver interrupt)
	5	82C54RH timer one
	6	ICL7115 EOC (end of A/D conversion)
Lowest	7	8273 Flag detect (FLAGDET*)

6. I/O device chip selection

Five devices and two special commands have been mapped to the PANSAT processor I/O address space. The highest address bit used by these devices is BA2. This leaves BA3 through BA15 for decoding chip select. Chip selection can be easily performed by a 54HC128 three to eight line decoder. Address lines BA3 through BA5 are used for chip selection. The 54HC138 output is enabled by M/IO* indicating an I/O space transfer; otherwise the decoder outputs are disabled. Address bits BA6 through BA15 are not used in decoding. This implies that the device selection repeats every 64 (40h) addresses up to the maximum address of 65535h. (For example, address 0042h is the same as 0002h). One 54HC138 output is unused, allowing addition of an another peripheral without revising I/O device chip select decoding. The I/O space map is shown in Figure 15 on page 50. Recommended I/O device addresses and actions are summarized in Table 13 on page 52.

7. I/O device timing requirements

Although most of the peripheral devices selected are designed to work specifically with the 80C86RH, a timing analysis must be performed to verify that all read and write times are satisfied. The I/O write cycle will be analyzed first. The 80C86RH provides a 340 nanosecond (minimum) write pulse. This guarantees at least a 352 nanosecond data setup time before WR* goes inactive. The peripheral requirements are shown in Table 14 on page 50. This shows that no wait states are required to satisfy peripheral write timing requirements. The resulting system peripheral write timing is shown in Figure 16 on page 51.

A preliminary analysis of an 80C86RH I/O read cycle shows that 399 nanoseconds is available for address access, 364 nanoseconds for chip select access, and 179 nanoseconds read access time. Timing for this cycle is shown in Figure 17 on page 54. The requirements for the various peripheral devices are shown in Table 15 on page 53. Several devices will not meet the minimum guaranteed read access time in all cases. RD* may go active as early as 10 nanoseconds into T2, but as late as 165 nanoseconds. A wait state must be inserted to satisfy worst case timing.

The required wait state can be generated by adjusting the inputs to the 82C85RH ready signal generator. The READY input to the 80C86RH must be disabled by the end of T2 (8 nanoseconds into T3) to guarantee the insertion of a wait state [Ref. 11 : p. A-23]. Two ready inputs are available to the 82C85RH ready generation circuit. In ASYNC mode, an inactive ready input causes the ready output to go inactive at the next downward clock transition. An active ready input is first synchronized to the up-

```
FFFFh
        (ADDRESS SPACE REPEATS EVERY 40h)
0040h
003Fh
        VACANT
0038h
0037h
        RxDACK* (8273)
0030h
002Fh
        TxDACK* (8273)
0028h
0027h
        INTERRUPT CONT. (82C55RH)
0020h
001Fh
        A/D CONVERTER (ICL7115)
0018h
0017h
        TIMER (82C54RH)
0010h
000Fh
        PARALLEL PORT (82C55RH)
0008h
0007h
        HDLC (8273)
0000h
```

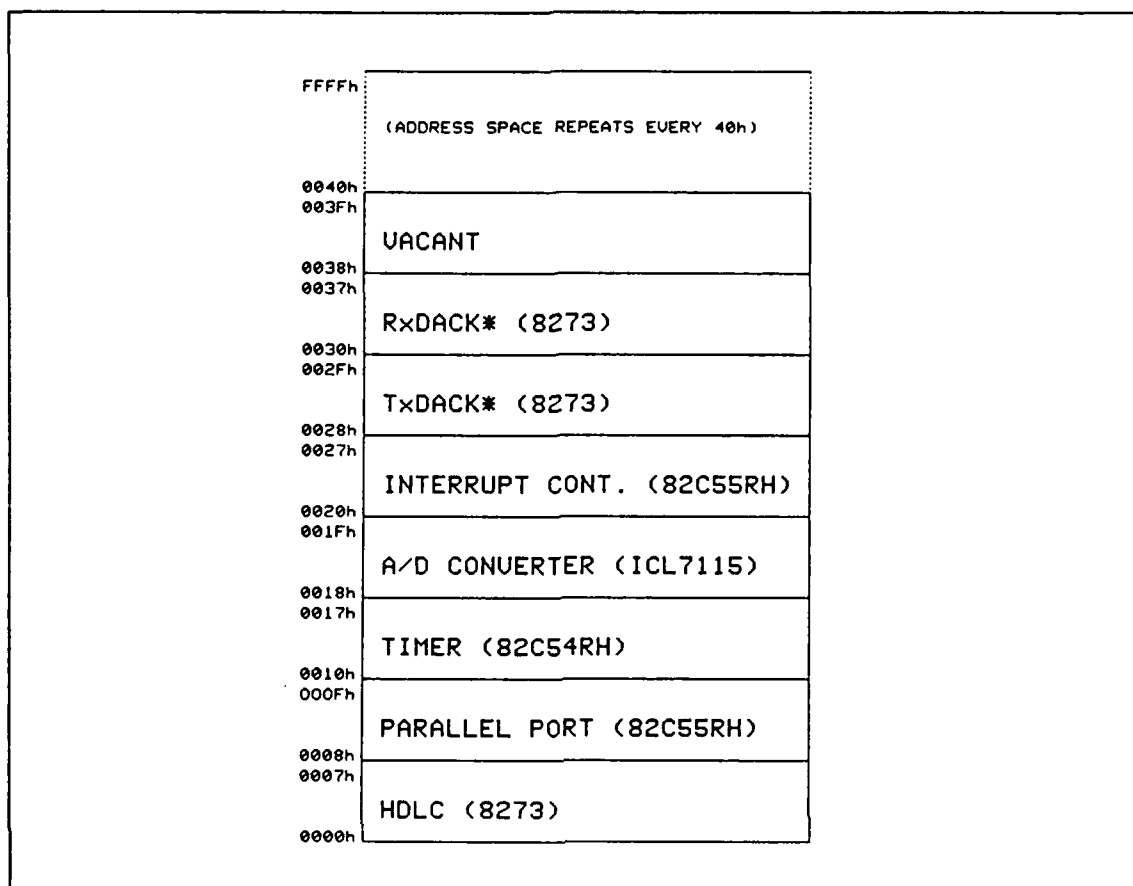Figure 15. PANSAT I/O space map

Table 14. PERIPHERAL DEVICE WRITE TIMING REQUIREMENTS

Device	Write pulse width	Data setup to WR* inactive
ICL7115	100 nsec	n a
8273	250 nsec	150 nsec
8273 TxDACK	250 nsec	150 nsec
82C54RH	240 nsec	225 nsec
82C55RH	100 nsec	100 nsec
82C59RH	160 nsec	160 nsec
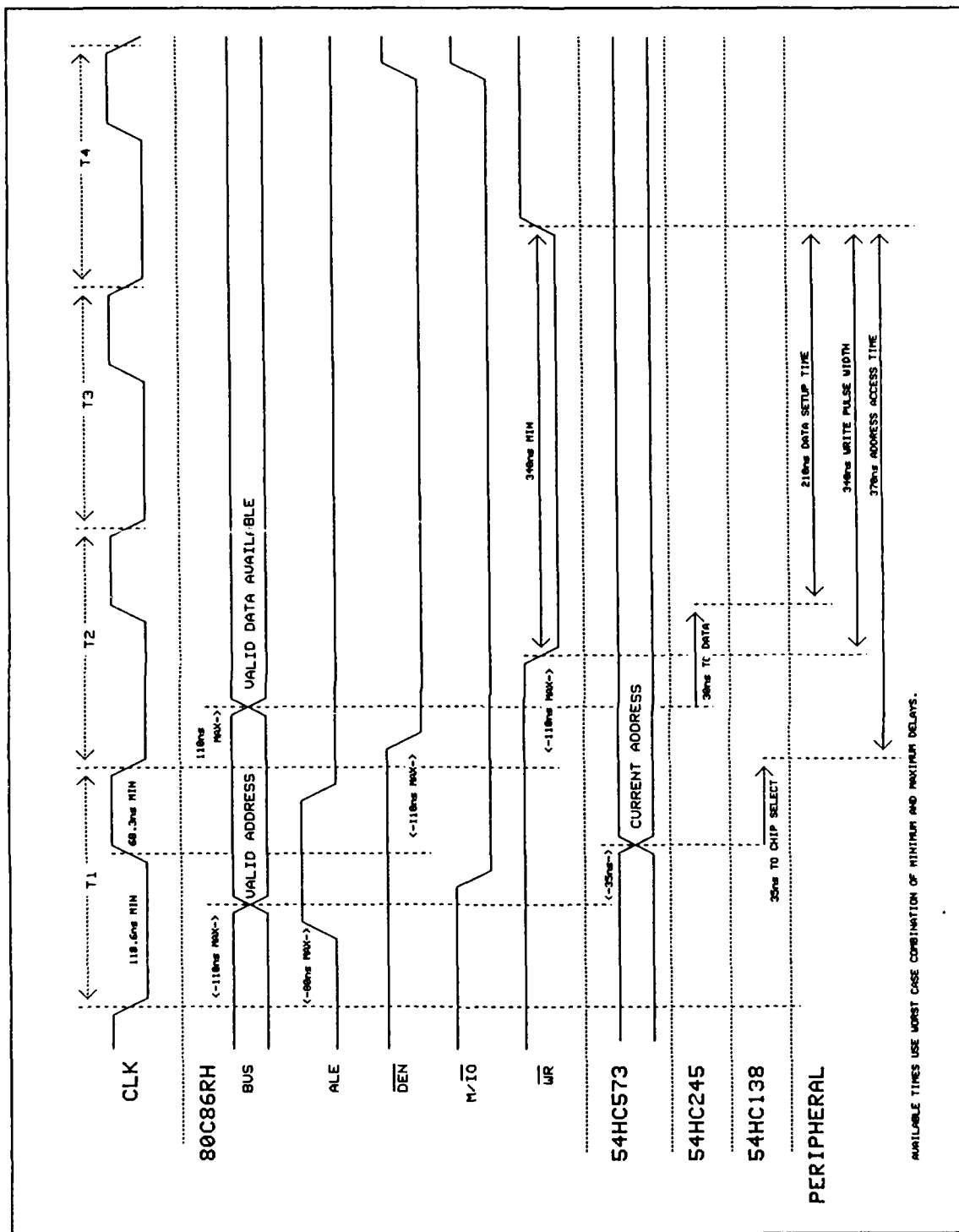
Figure 16.   Peripheral device write timing

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Table 13. PANSAT I/O DEVICE VALID ADDRESSES

Device	Address	Operand size	Action
HDLC (8273)	00h	byte	WR* = 0 command register RD* = 0 status register
	02h	byte	WR* = 0 parameter register RD* = 0 result register
	04h	byte	WR* = 0 8273 reset RD* = 0 TxINT result
	06h	byte	WR* = 0 (none) RD* = 0 RxINT result
	28h	byte	transmit data register
	30h	byte	receive data register
Parallel port (8255)	08h	byte	port A (TLM control)
	0Ah	byte	port B
	0Ch	byte	port C (device control)
	0Eh	byte	parallel port control word
Timer (8254)	10h	byte	counter 0
	12h	byte	counter 1
	14h	byte	counter 2 (watchdog timer)
	16h	byte	timer control word
A D Converter (ICL7115)	18h	byte	WR* = 0 initiate conversion RD* = 0 low byte of result
	1Ah	byte	RD* = 0 high byte of result
	1Ch	word	both bytes of result
Interrupt controller	20h	byte	command register 0
	22h	byte	command register 1

ward clock transition, then the READY output goes active at the next downward transition, meeting the minimum 80C86RH setup requirements. The ASYNC* input is connected to ground to select ASYNC mode. One 82C85RH ready input will be dedicated to memory operations. For the present, RDY1 will be connected to M/IO*. The system will normally be ready if memory operations are in progress. (This assumption may be changed during memory system design.) However, this signal goes inactive during I/O operations. This allows the other ready input to control ready generation during I/O cycles. The second input, RDY2, is connected to the output of a 54HC00

Table 15. PERIPHERAL DEVICE READ TIMING REQUIREMENTS

Device	Address access time	Chip enable access time	Read active access time
ICL7115	200 nsec	200 nsec	200 nsec
8273	300 nsec	300 nsec	300 nsec
8273 RxDACK	300 nsec	n a	200 nsec
82C54RH	75 nsec*	0 nsec*	200 nsec
82C55RH	0 nsec*	0 nsec*	200 nsec
82C59RH	210 nsec	210 nsec	160 nsec
* indicates setup time before RD* goes active			

NAND gate with RD* and WR* as inputs. See Figure 10 on page 36 for connections. These connections result in a wait state being generated if RD* or WR* is not active within 45 nanoseconds after the start of T2. (The 82C85RH requires a 55 nanosecond setup time. With an 18 nanosecond delay through the 54HC00 and the active clock edge occurring at 118.6 nanoseconds, this leaves 45.6 nanoseconds for RD* or WR* to go active without generating a wait state.) The resulting access times with the wait state added are shown in Figure 18 on page 55. Figure 19 on page 56 shows the resulting times if RD* does go active within 45 nanoseconds of the start of T2.

This design may result in addition of wait states for an I O write which are not needed. However, if the decision to insert a wait state is delayed until RD* or WR* go active, then the 82C55RH minimum setup times are violated and the required wait state may not be generated. The simplicity of this design outweighs this occasional slowing of I O writes.

G. MEMORY SYSTEM DESIGN

Memory design is affected by the following considerations:

- The processor must be able to independently address either the lower byte or the upper byte, or the entire 16 bit word.

- The lowest locations in memory are reserved for the interrupt vector table.

- Program execution begins at location FFFF0h after reset.

- Static RAM is preferred for reliability reasons and to keep the design simple.

- Memory circuits may be located on a separate circuit board; connection of the memory to the main board must be considered.
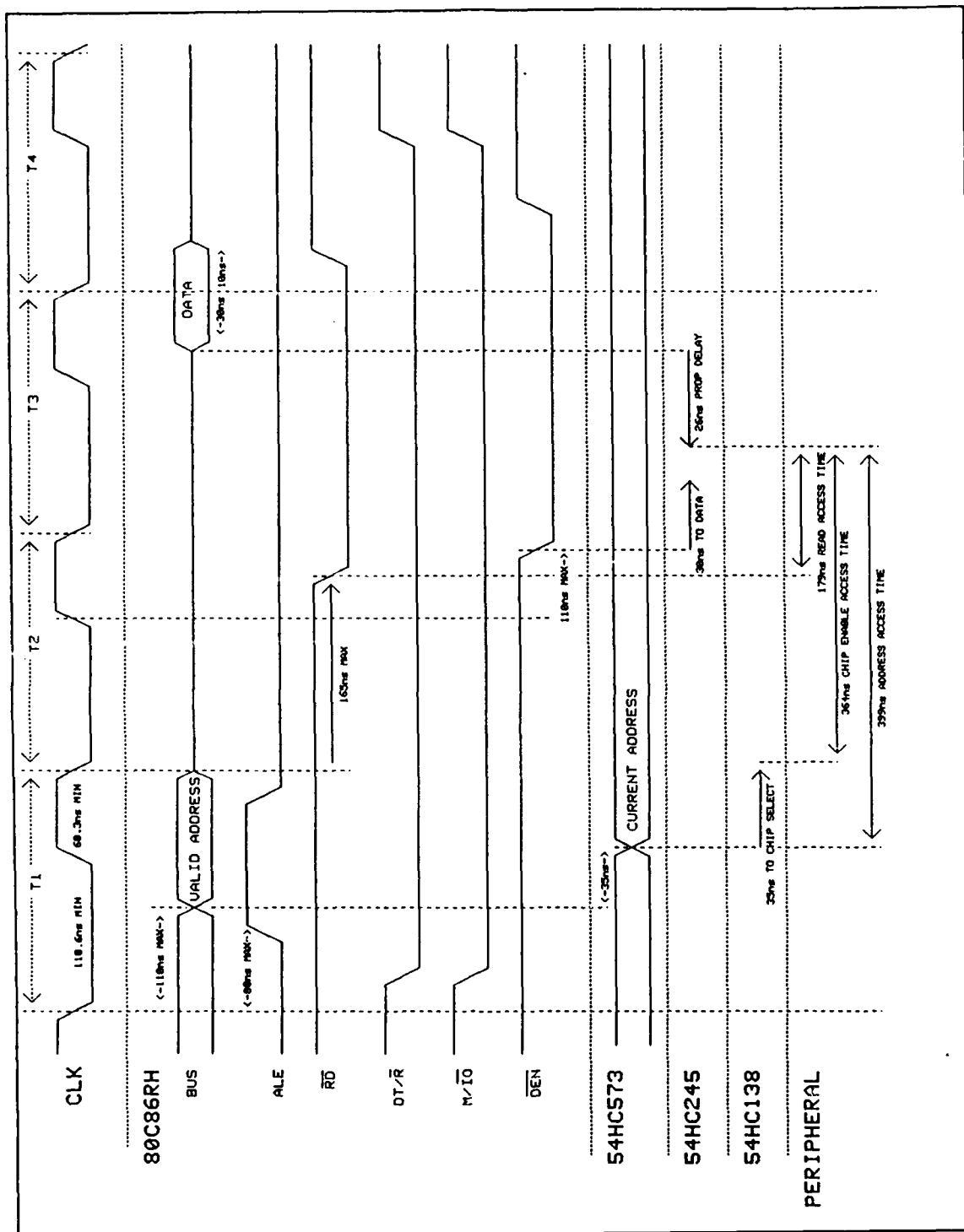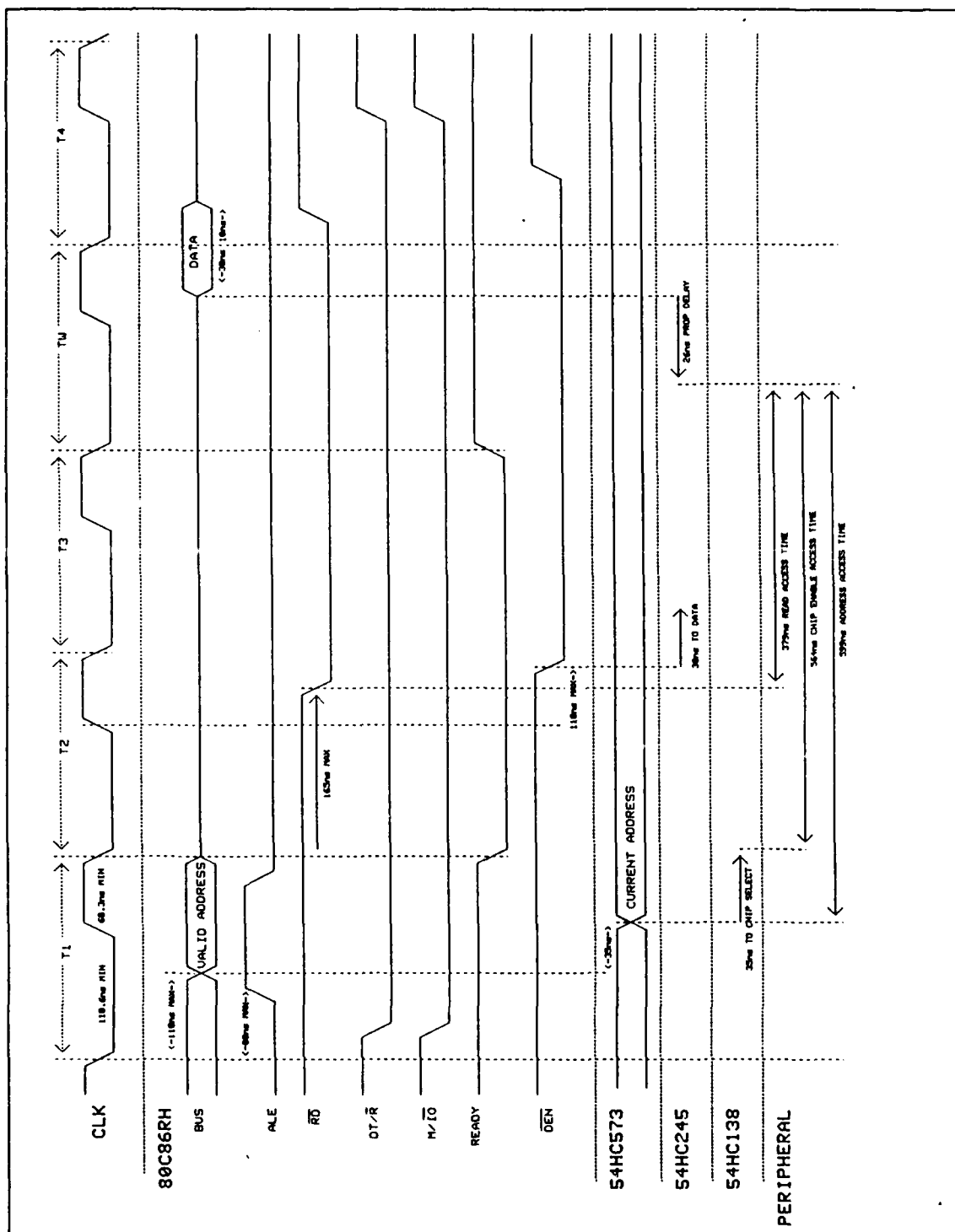
Figure 17. I/O initial read timing analysis

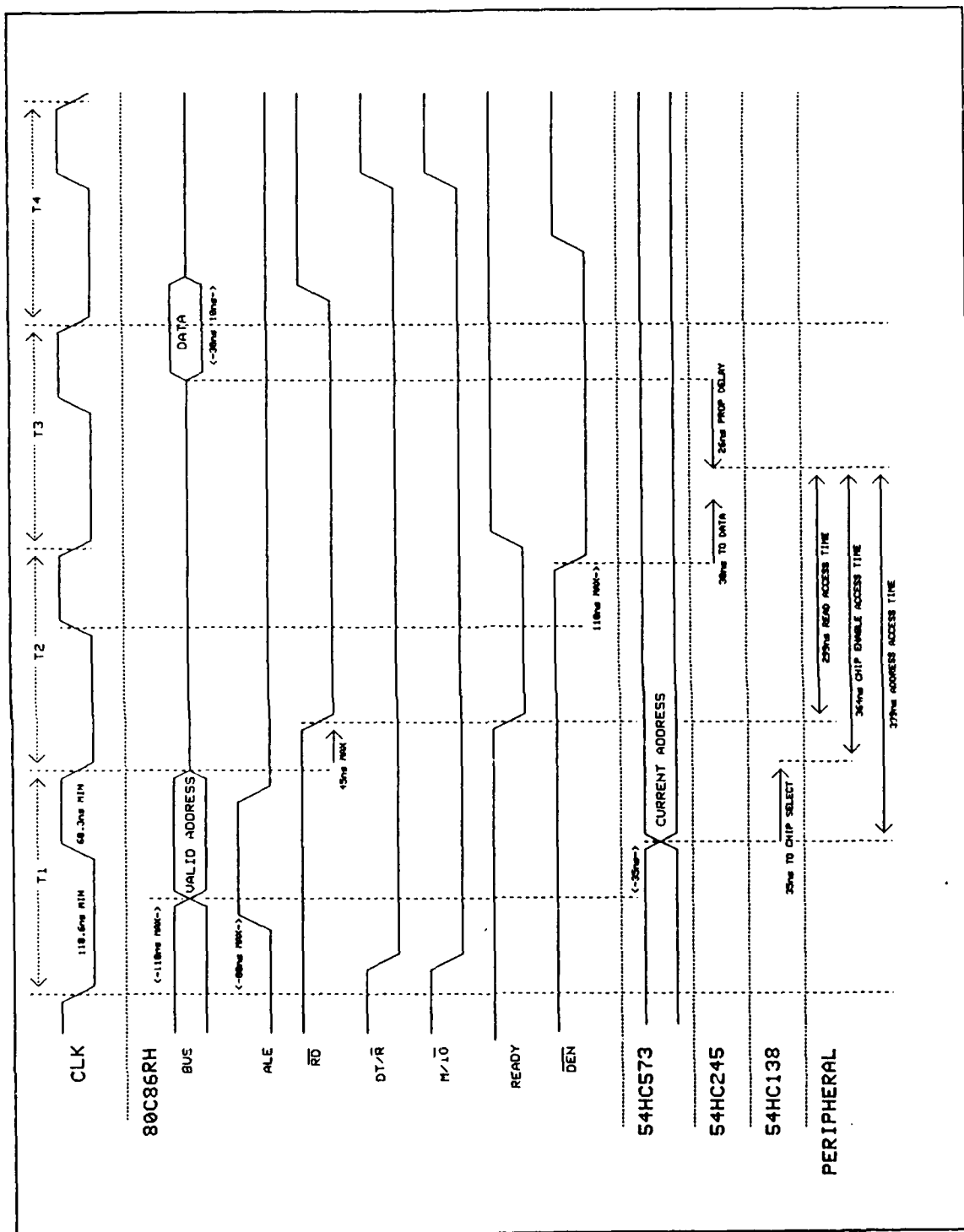Figure 18.   I/O read timing analysis with one wait state

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Figure 19. I/O read timing analysis with RD* meeting setup requirements

PANSAT memory is to be divided into three sections: PROM, vital RAM, and bulk storage RAM. To satisfy the above requirements, the PROM should be located at the top of memory and contain the restart routine. Likewise, the vital RAM should be located at the bottom of memory to hold the interrupt vector table. (Since the watchdog timer uses the non-maskable interrupt, this pointer is considered vital.)

Memory boards can be connected to the main board either by the system (multiplexed) data bus, or the separate, demultiplexed address and data buses. Using the system bus requires each memory board to have separate address latches and data transceivers. While this prevents failure of one set of address latches from causing complete system failure, the overall system becomes more complex, therefore more prone to failure. Additionally, this increases the required output drive from the 80C86RH. For these reasons, using the demultiplexed address and data bus to connect the memory boards is preferred. The required signals are BA0-BA19, BD0-BD15, RD*, WR*, BHE*, and M IO*.

Design is also constrained by available technology and cost. Although one megabit static RAMs have just been announced (by at least one vendor), the largest commonly used size is 256 kilobit. These are currently available in high reliability versions. Radiation hardened RAM is currently more limited, being available in 64 kilobit versions. As technology continues to advance, higher density devices will become available in radiation hardened versions. This presents a problem in memory system design. Current device availability or cost constraints may not apply as PANSAT approaches launch. For this reason, a top down memory decoding scheme will be adopted which will readily adapt to changing availability of high density, radiation hardened RAMs and PROMs. The specific devices that are actually implemented may be changed due to cost, availability, or other concerns without requiring a complete redesign.

PANSAT memory will be divided into 64 kilobyte sections by using the four most significant address bits. This is easily accomplished using two 54HC138 three to eight line decoders. These decoders are enabled only when M/IO* is high. This is accomplished by connecting M/IO* to a 54HC04 inverter, then to the G2* (active low) enable input. (Only one active high enable exists on the 54HC138 and two are needed. Either M IO* or BA19 could be inverted. BA19 already has an additional delay through the 54HC573 addresses latches, therefore inverting M/IO* adds no additional delay.) The lowest section will be reserved for vital RAM. The highest section will contain the PROM. Remaining sections will contain the bulk RAM. This approach allows flexibility to change devices and the decoding scheme within any section without affecting the

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overall design. The 64 kilobyte division allows two 32 kilobyte by eight bit (256 kilobit) static RAMs to be used in each section without further decoding. If memories larger than 256 kilobit are to be used in the final implementation, the memory system must be redesigned.

Only devices which are known to be currently available and about which firm data is known were considered. There may be a device among the dozens of manufacturers that would be better than those chosen but this design will be shown to be sufficient.

The requirement to address low byte, high byte, or both implies that the memory must be 16 bits wide. Table 6 on page 31 shows how selection is conditioned on A0 and BHE*. This implies that BA0 will not be used internal to the memory devices for byte selection. BA1 is the least significant address bit used internal to the memories. The distinction between low and high byte need only be made during write cycles. During read, the processor only latches the byte required from either the low or high byte of AD0-AD15, and internally routes it to the proper register. Write of even addresses must be conditioned on A0 being low. Write of odd addresses must be conditioned on BHE* being low.

All memory device output enables are controlled by the RD* signal generated by the processor. This helps eliminate data bus contention between memory devices on consecutive memory read accesses.

1. Programmable read only memory

Two 2048 byte CMOS 6616RH PROMs will be used for permanent program storage. These will be located at the top of the memory address space, occupying addresses FF000h to FFFFFh. These devices are a radiation hardened version of the standard 6616 PROM. This device is also synchronous, but the synchronous capability will not be exploited in this design. The device will be connected similar to an asynchronous memory device; its access times are sufficiently fast that this will not require addition of wait states. One device will contain even addresses, the other odd addresses. To meet the redundancy discussed earlier, these devices will be duplicated. A circuit using one 54HC73 J-K flip flop and two 54HC32 OR gates will be used to select one of the PROM pairs. The J-K flip flop is connected as a toggle flip flop and uses RESET as a clock pulse. The Q and Q* outputs alternately enable the PROM sets. This scheme relies on the communication system to provide the reset input, otherwise another method must be provided to select the active PROM. (Selection must not presume that the processor is operating properly.) The PROMs are read only, therefore there is no need to differentiate between low and high bytes. The top 64 kilobyte section must be

divided into four kilobyte subsections for the two 6616RIIs. This is accomplished by a second 54HC138 which uses BA12-BA15 and the primary 54HC138 output as inputs. The circuitry is shown in Figure 20 on page 60. Figure 21 on page 61 shows the resulting system timing. All timing requirements are satisfied with no wait states.

During system construction and test, the PROMs will be replaced with EPROMs. The timing for these devices will need to be verified when they are specified.

The redundant capability of the PROMs is not matched in the decoding circuitry that selects the PROMs. At a slight increase of complexity the decoding circuitry can be made redundant. The output of the J-K flip flop can be used as an enable input for the first level 54HC138s. The Q output would be connected to one 54HC138 G2B* input with the Q* output connected to the other primary 54HC138. Toggling the flip flop would alternately select the two decoding circuits. An additional advantage of this circuit is that the 18 microsecond delay through the OR gate is eliminated, increasing the read cycle margin. This modified circuit is shown in Figure 22 on page 62. The modified PROM read data timing analysis is shown in Figure 23 on page 63. The simpler, unmodified circuit is used in system power analysis. Specifications for the 6616RII are found in reference 6, pp. 3-45 to 3-51. Additional information on the radiation tolerance of this circuit is found in reference 6, pp. 13-12 to 13-17.

2. Vital read/write memory

Two eight kilobyte CDM6264CD 3 static RAMs are used for vital RAM. These devices should be procured in the radiation hardened version to meet the reliability requirement for vital RAM. They are located at the bottom of physical memory from address 00000h to 03FFFh. The bottom 64 kilobyte section must be subdivided into 16 kilobyte sections. This is accomplished by using a 54HC139 two to four line decoder. This decoder uses BA14, BA15, and the primary 54HC138 as inputs. The circuitry is shown in Figure 20 on page 60. Read data timing is shown in Figure 24 on page 64. This shows that critical path timing (chip enable path) is satisfied with a 184 nanosecond margin with no wait states. Write data timing is shown in Figure 25 on page 65. Critical path timing (data setup time) is satisfied with a 168 nanosecond margin.

An alternative to the CDM6264CD 3 is the HS-65C162RII static RAM. This is a 2048 word device available in a radiation hardened version. A minimum of two devices would be required to implement a 16 bit memory. The secondary decoder must be changed to a 54HC138 to use these smaller memories. Specifications for this device are found in Reference 6, pp. 3-29 to 3-32. Device specifications for the CDM6264CD 3 are found in Reference 15 .
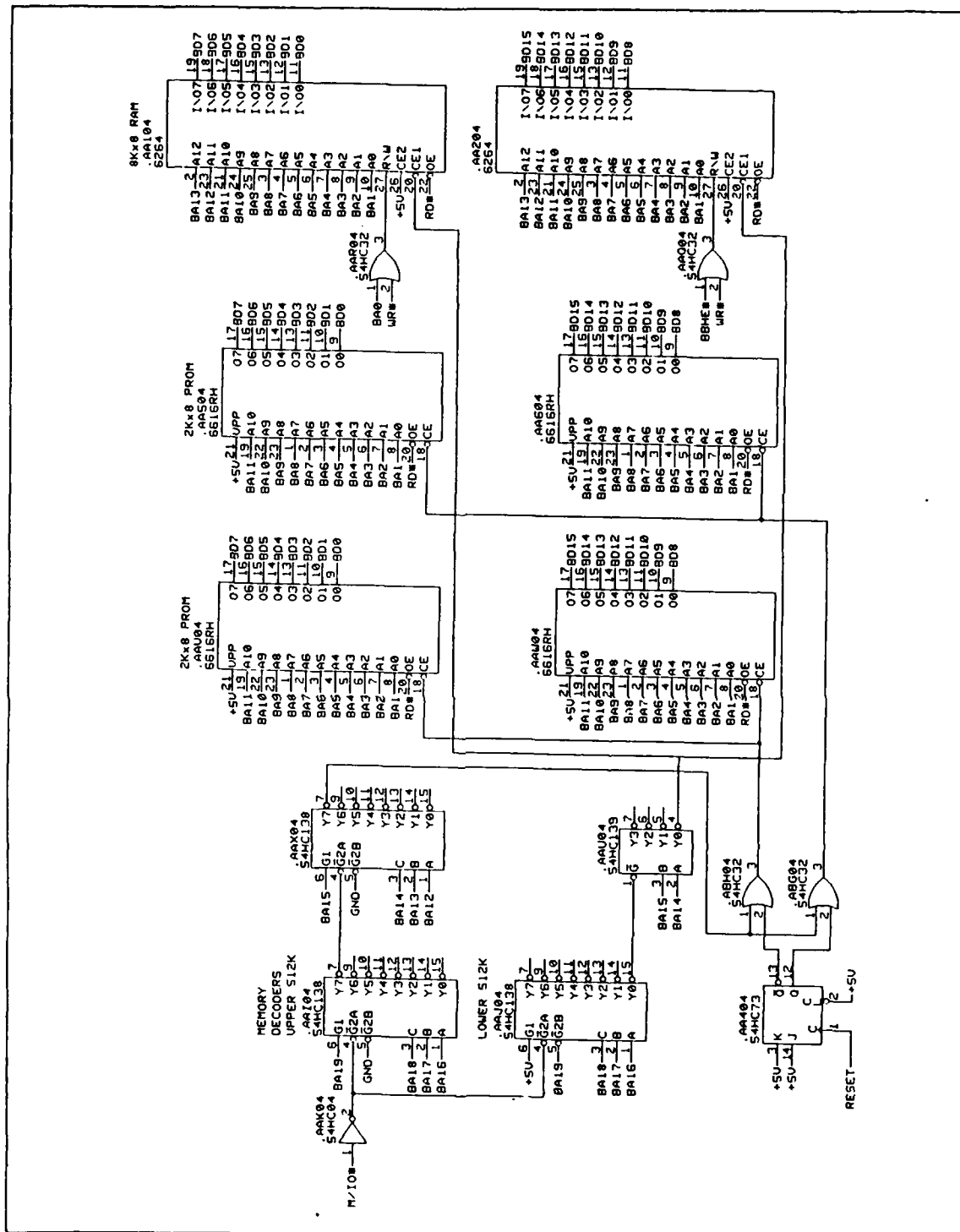
Figure 20. PROM and vital RAM

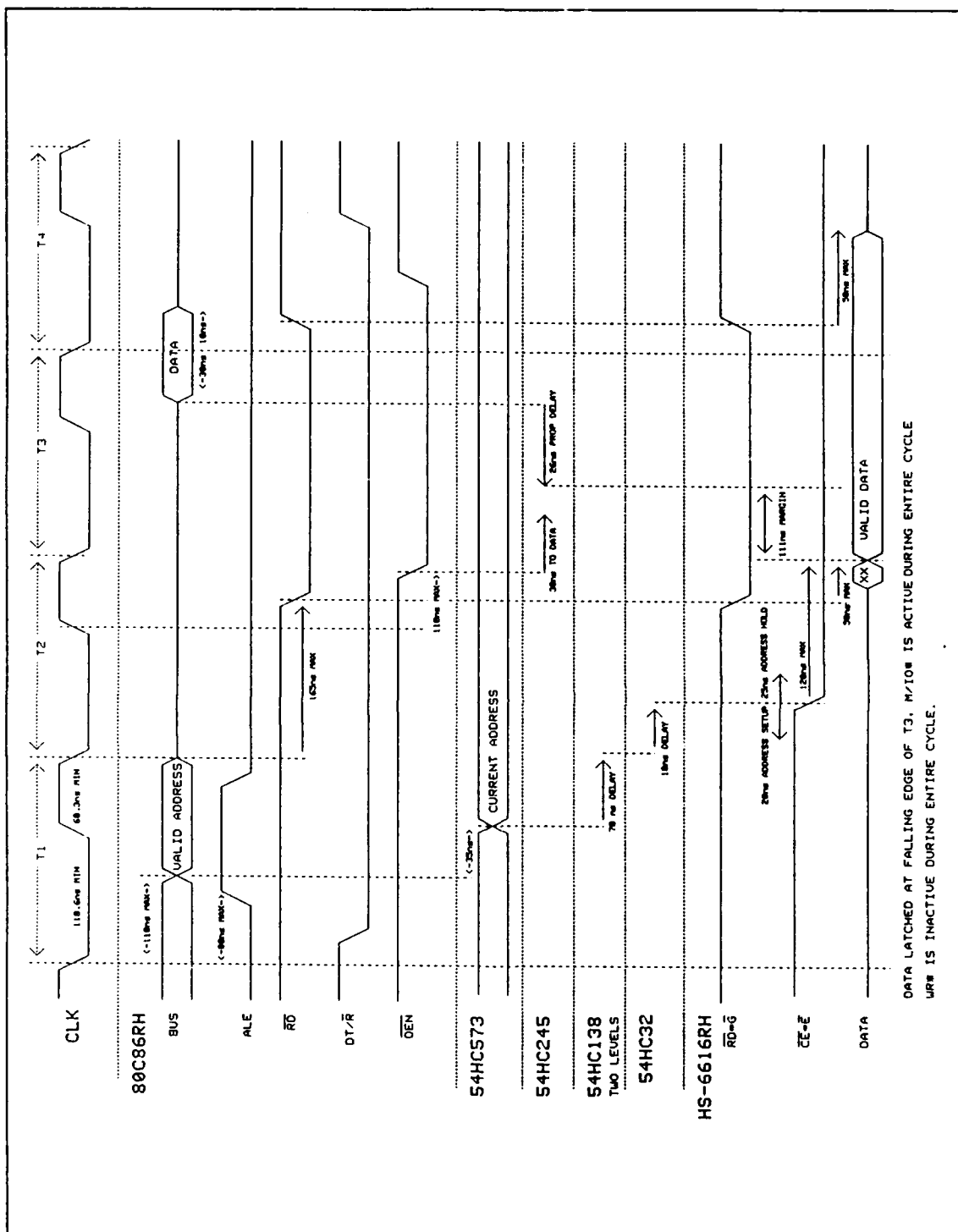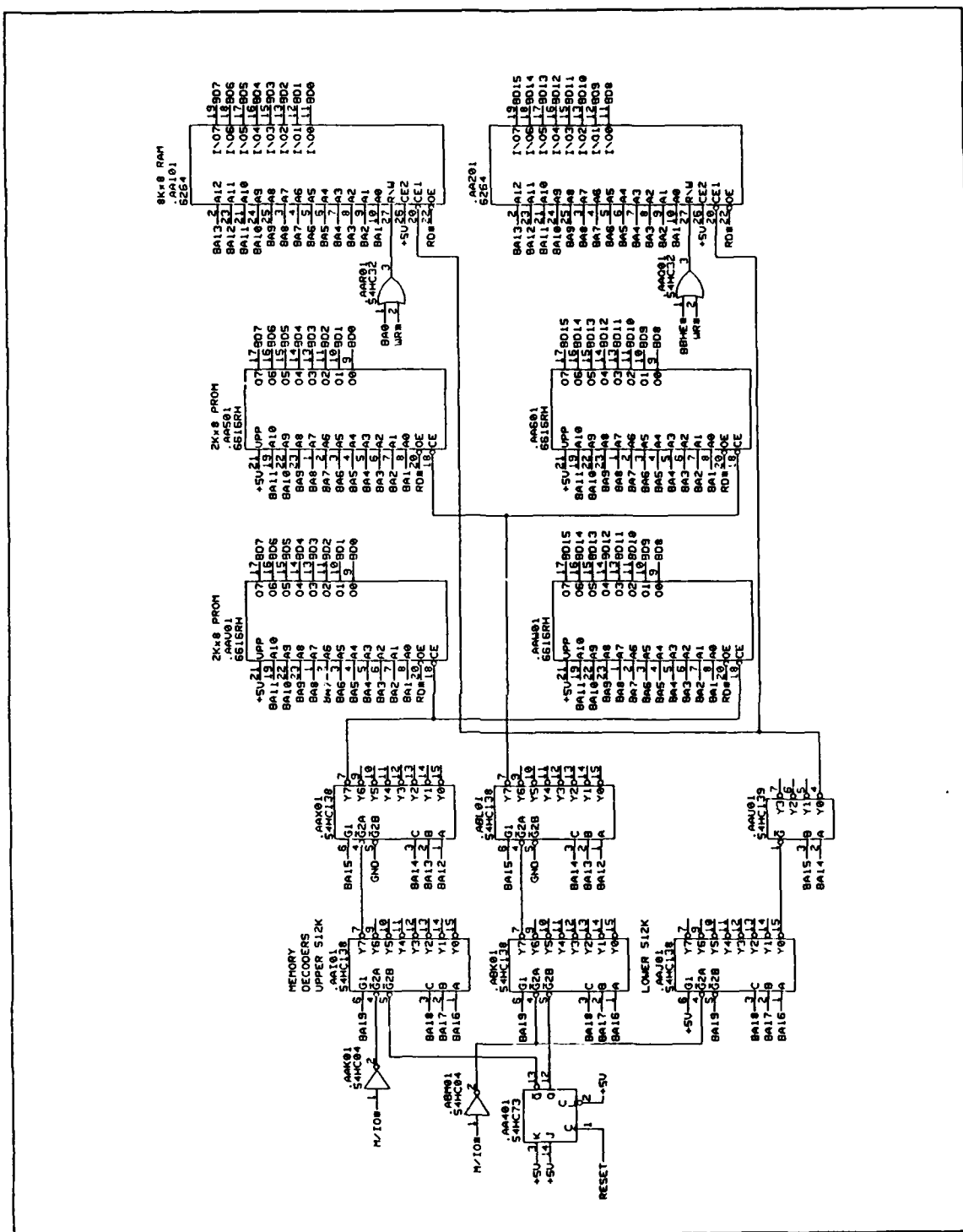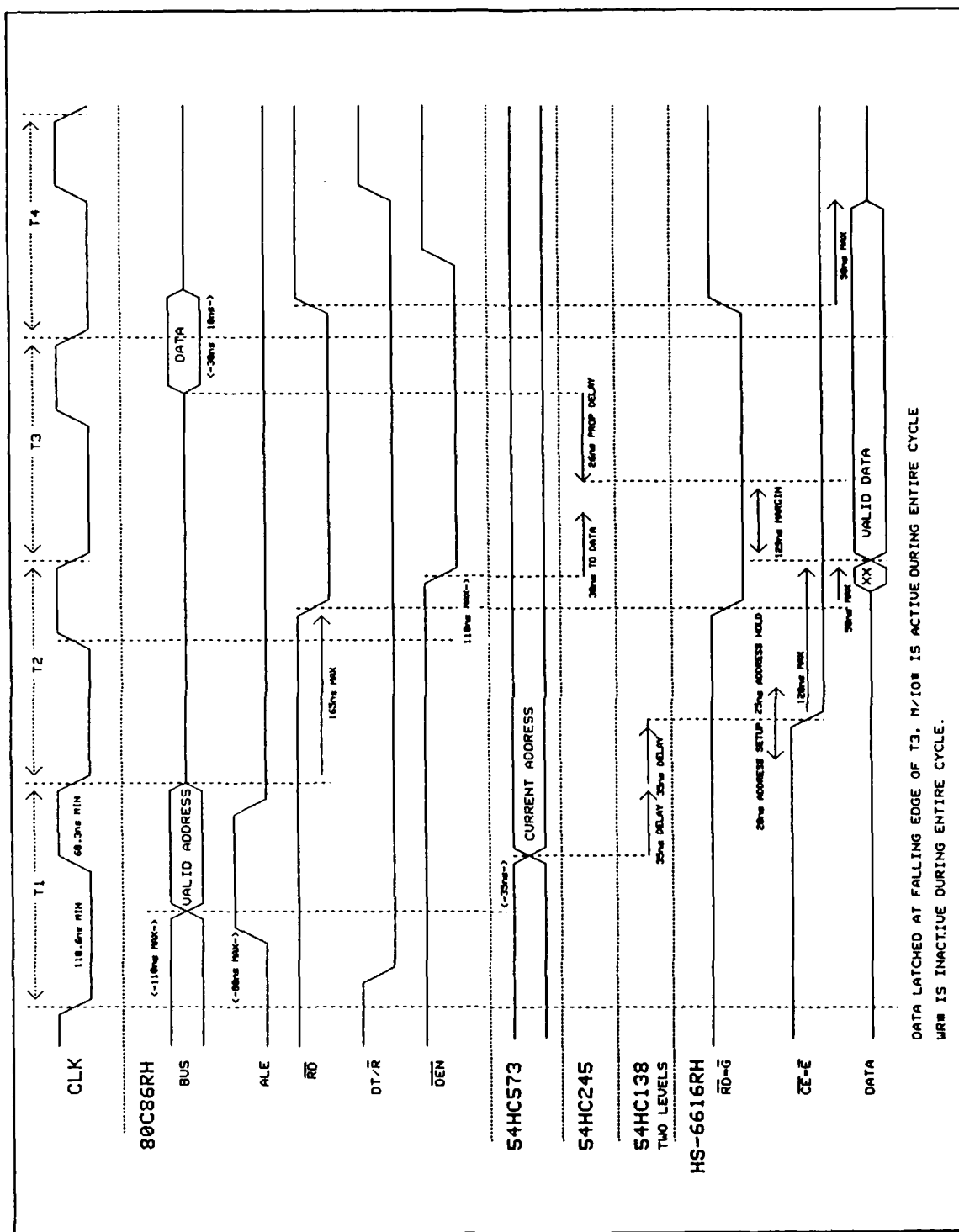Figure 21.   PROM read data timing analysis
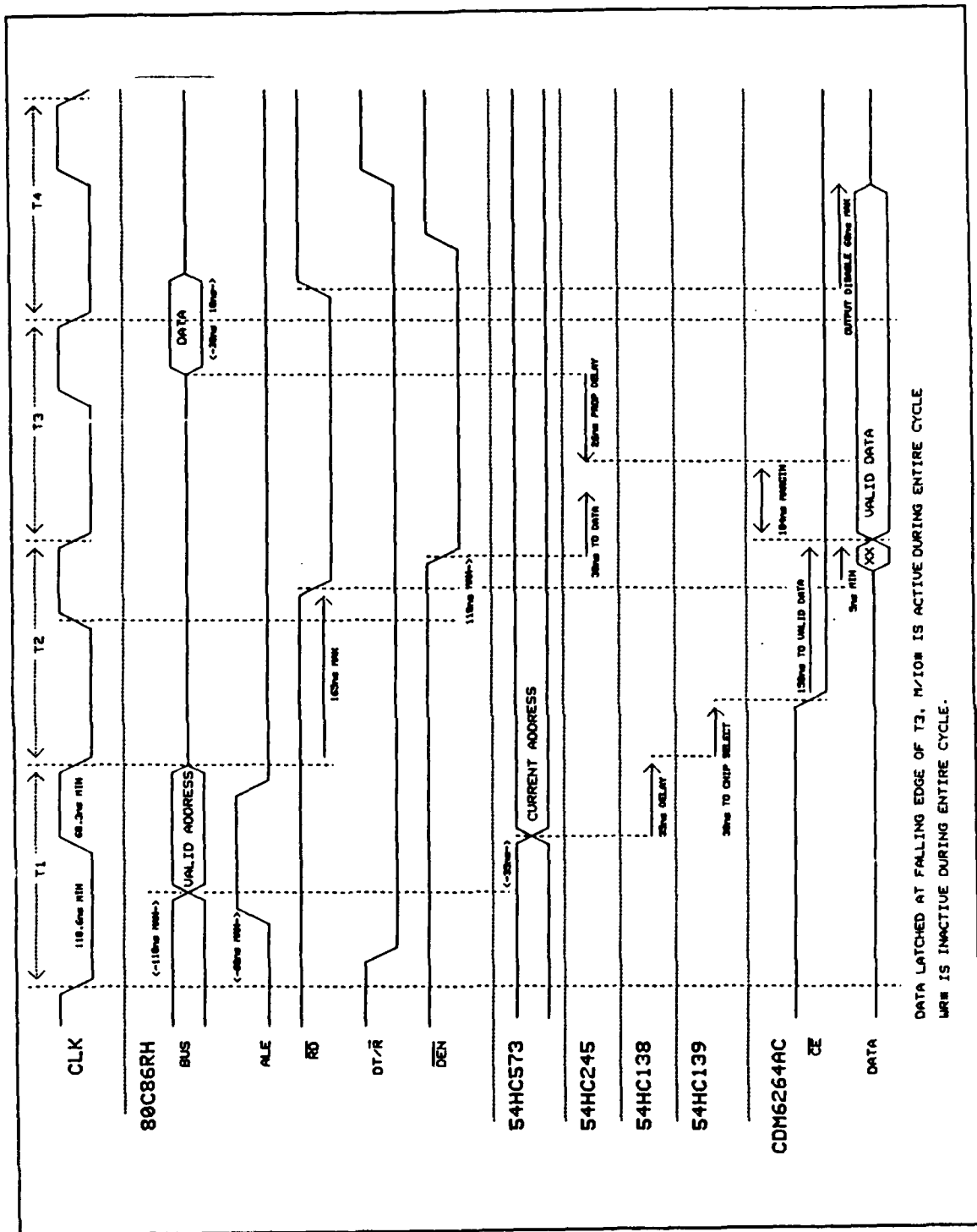
61

Figure 22. Modified PROM decoding circuit

62

Figure 23. Modified PROM read data timing analysis

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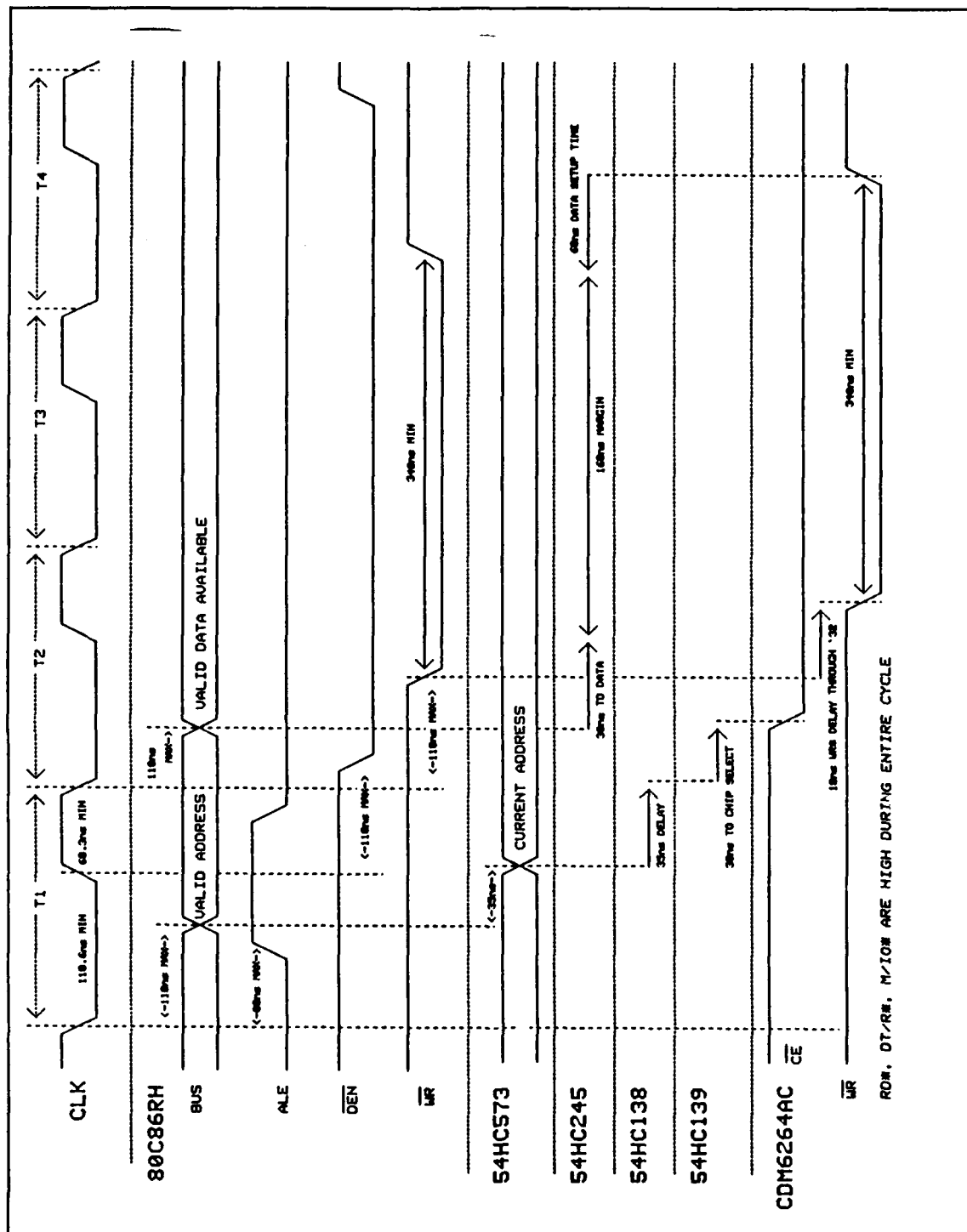Figure 24.   Vital RAM read data timing analysis

Figure 25. Vital RAM write data timing analysis

3. Bulk read/write memory

The bulk RAM will be implemented in CDM62256 32 kilobyte static RAMs. Sixteen of these devices will provide 512 kilobytes of storage. This will be sufficient for the store and forward message buffer or for holding telemetry or experiment data. Two of these devices will be used in each 64 kilobyte section. The only additional decoding required (beyond the top level 54HC138) is selection of even or odd byte (or both) for a write cycle. Bulk RAM will occupy memory locations 10000h to 8FFFFh. To increase reliability, this RAM will be divided into four sections, each with a separate 54HC138 decoder and write conditioning circuit. The circuitry is shown in Figure 26 on page 67 and Figure 27 on page 68. The read data timing analysis is shown in Figure 28 on page 69. This shows that critical path timing requirements are satisfied with a 119 nanosecond margin and no wait states. The write data timing analysis is shown in Figure 29 on page 70. This shows that data setup times are satisfied with no wait states. Specifications for the CDM62256 are found in reference 16.

4. Memory summary

This design provides four kilobytes of PROM, 16 kilobytes of vital RAM, and 512 kilobytes of bulk RAM. The resulting memory address map is shown in Figure 30 on page 71.

H. POWER CONSUMPTION

The static power consumption for the LSI and MSI circuits is shown in Table 16 on page 72. This does not include the dynamic power required for operating circuits. The address latches and data bus transceivers are in continuous operation, as is the divide by 16 circuit and at least one memory decoder. Operating current is not directly available from the data book. However, each active output stage can be assumed to source or sink 20 microamps. If 50 output stages are assumed to be instantaneously operating, this equates to one milliamp. The total current draw for support circuitry is 4.8 milliamps. Assuming a five volt supply voltage, the power required is 24 milliwatts.

Static memory power consumption is shown in Table 18 on page 73. Total current required is $2^{\wedge}.44$ milliamps, or 102 milliwatts at five volts. Operating power is spread over the entire memory array. The largest operating current is the CDM62256. Each CDM62256 requires 90 milliamps. Assuming word operations, this is 180 milliamps, or 900 milliwatts. Total current required for memory operations is 200 milliamps, or one watt.
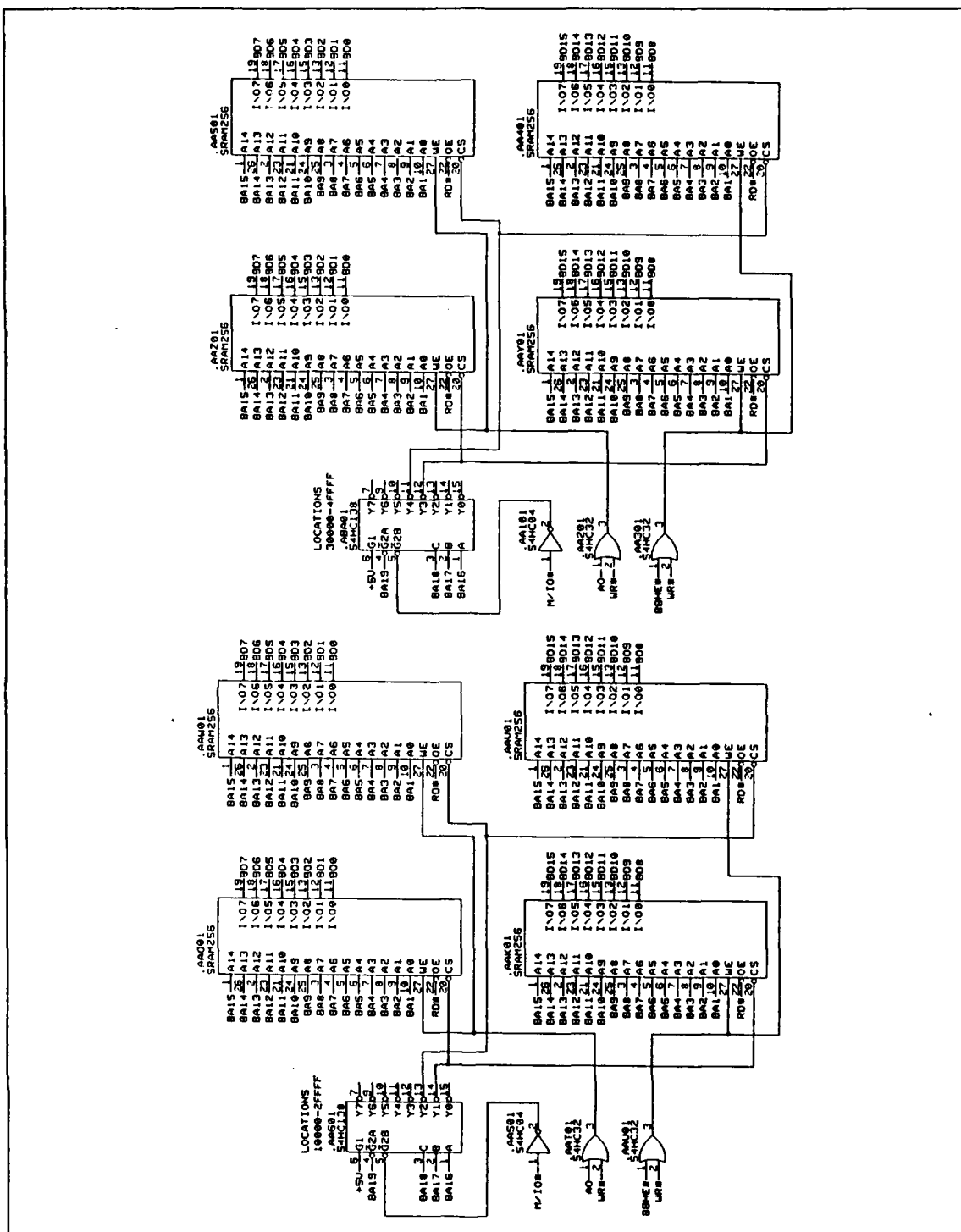
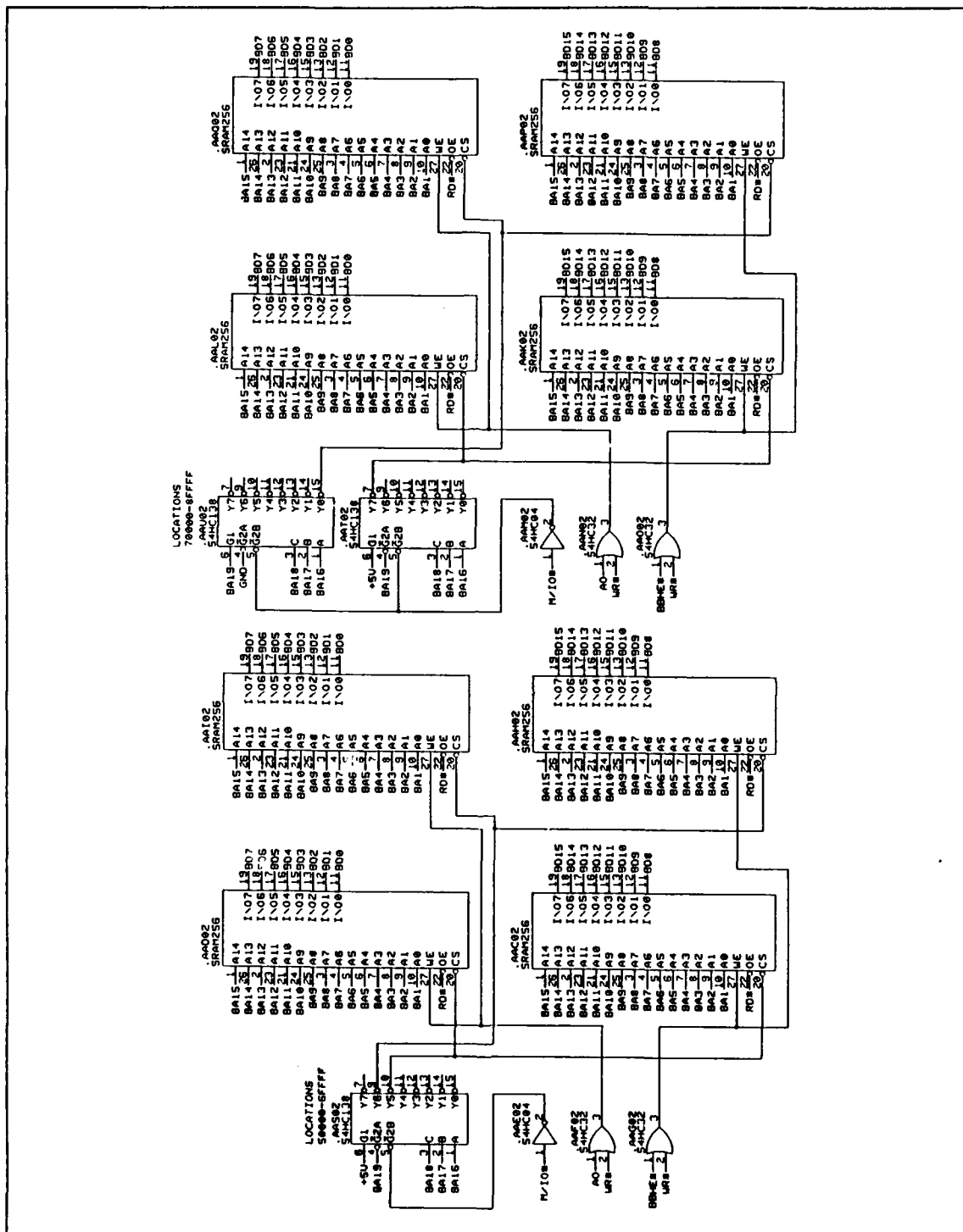Figure 26.   Bulk RAM (Addresses 10000h to 4FFFFh)
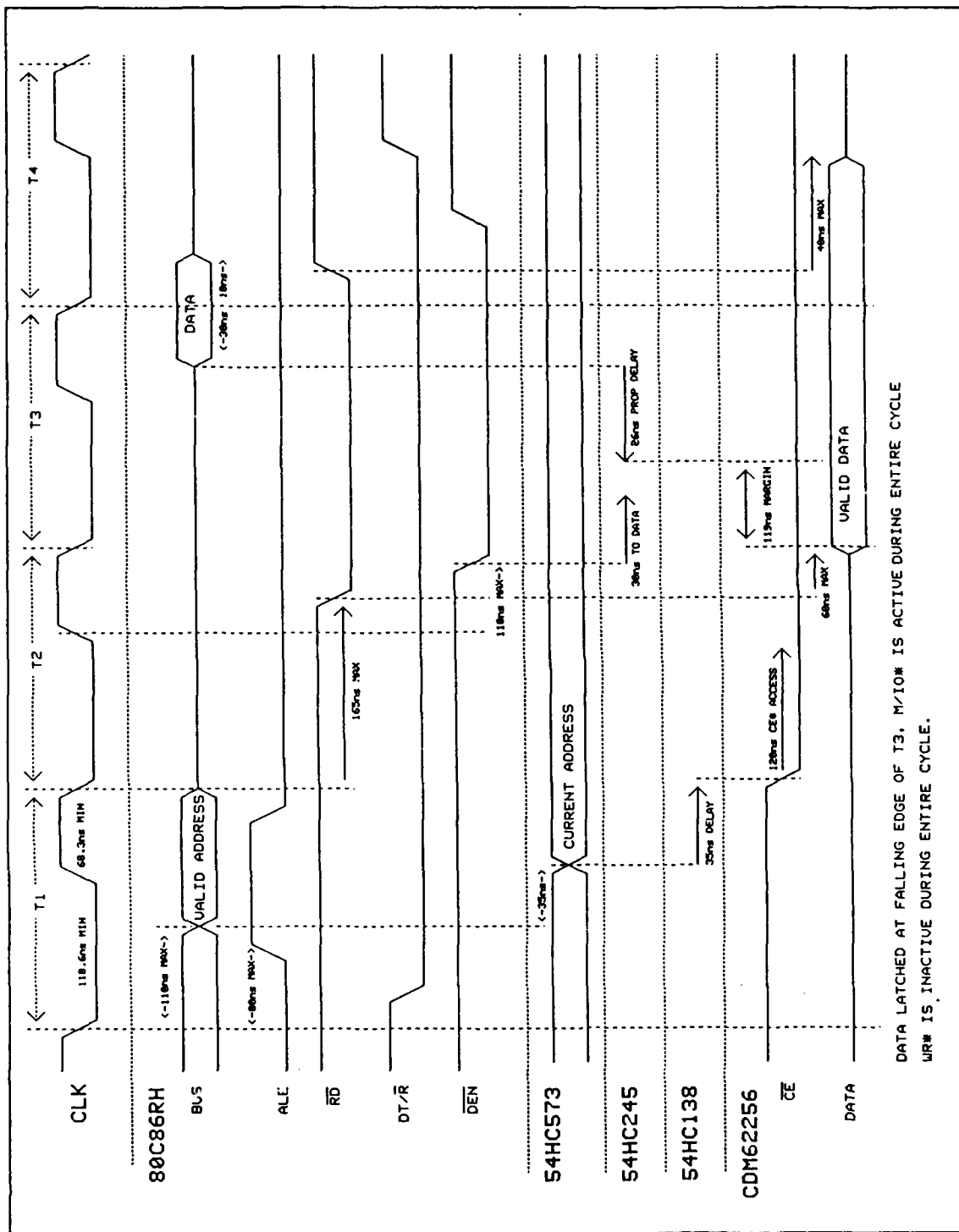
Figure 27. Bulk RAM (Addresses 50000h to 8FFFFh)
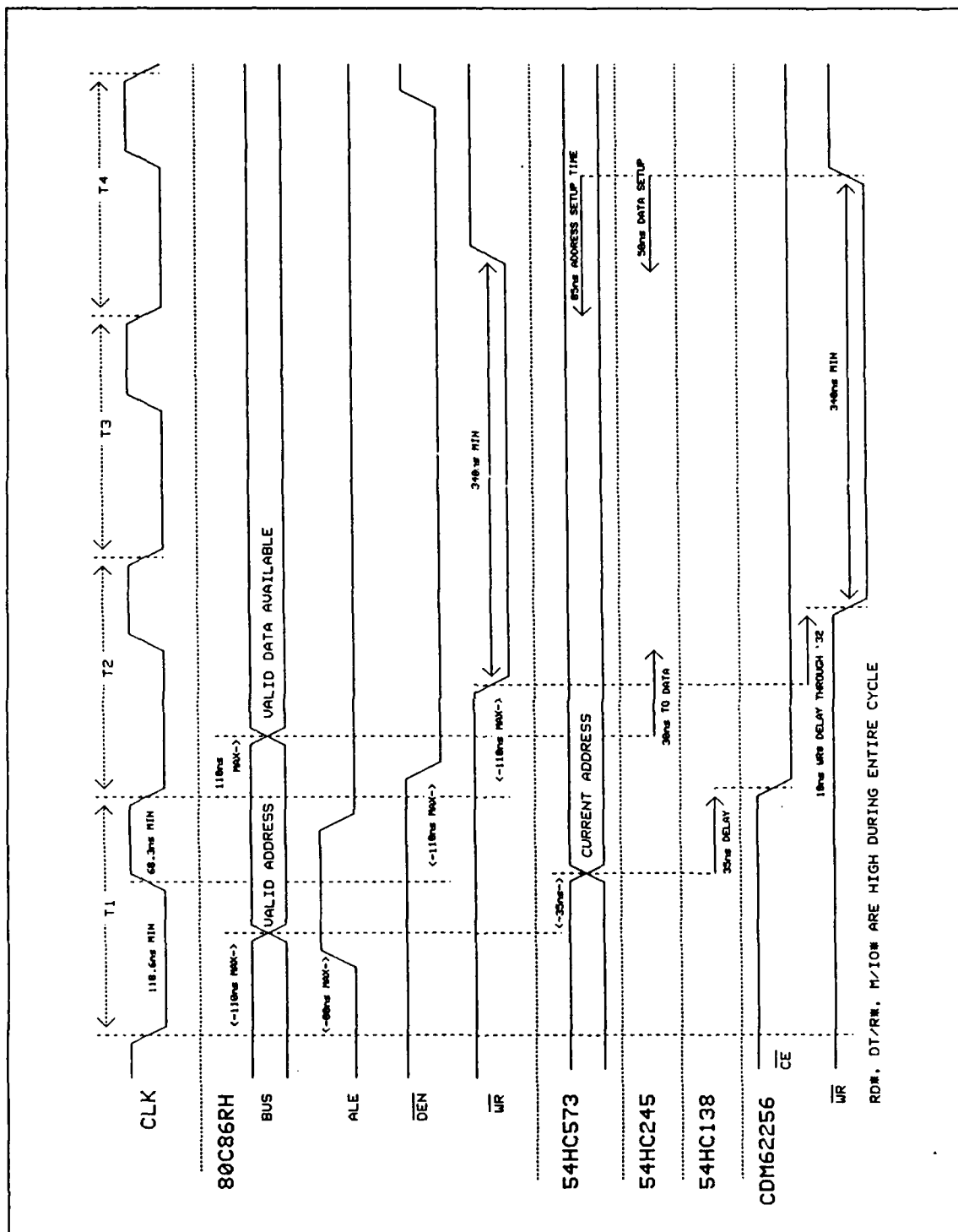
68

Figure 28. Bulk RAM read data timing analysis

Figure 29. Bulk RAM write data timing analysis

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```
FFFFFh  ┌──────────────────────┐
        │   PROM (6616RH)      │
FF000h  ├──────────────────────┤
FEFFFh  │////////////////////////│
        │////////////////////////│
        │////////////////////////│
        │////////////////////////│
        │////////////////////////│
        │////////////////////////│
90000h  │////////////////////////│
8FFFFh  ├──────────────────────┤
        │                      │
        │                      │
        │   BULK RAM (CDM62256)│
        │                      │
        │                      │
10000h  ├──────────────────────┤
0FFFFH  │////////////////////////│
        │////////////////////////│
04000h  │////////////////////////│
03FFFh  ├──────────────────────┤
        │   VITAL RAM (CDM6264)│
00000h  └──────────────────────┘
```
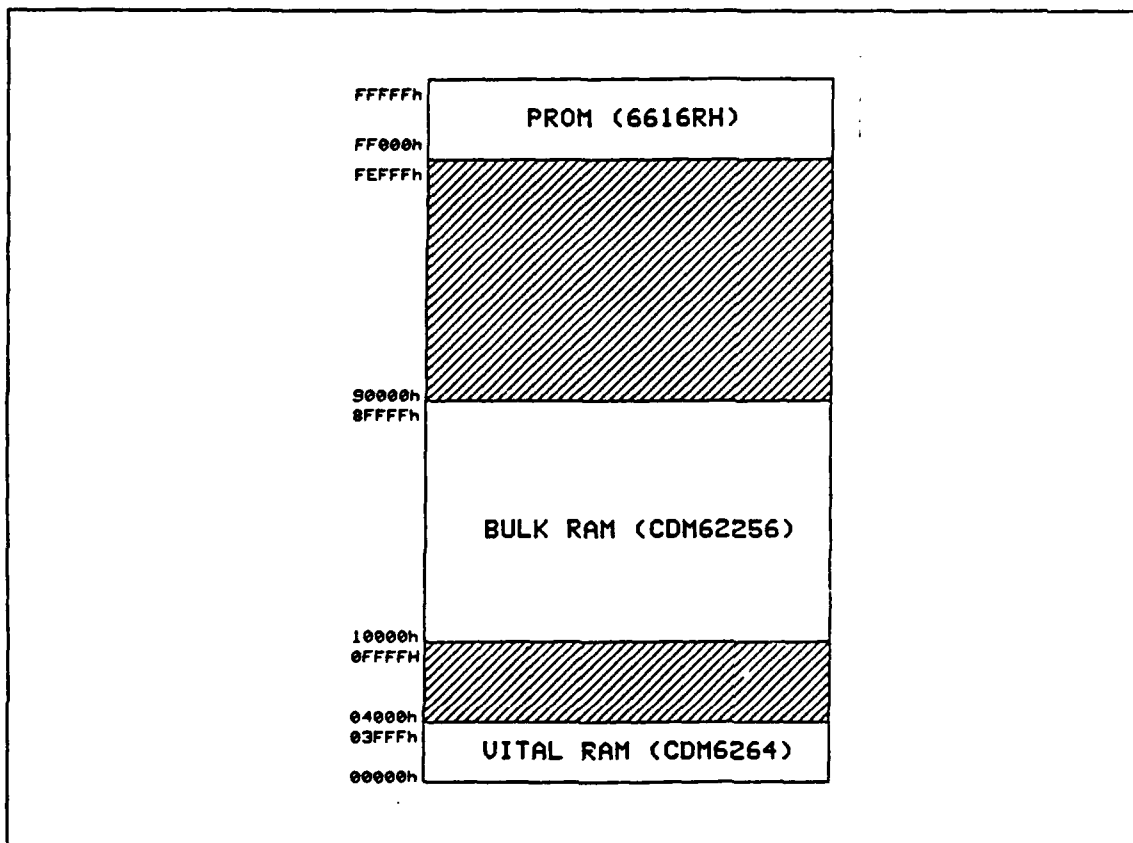
Figure 30.   PANSAT memory address map

The 80C86RH and associated LSI circuit power consumption is shown in Table 17 on page 72. A total current of 284 milliamps is required, or 1.42 watts at five volts.

The above power estimates use the military temperature rating (-55°C to +125 °C). Total current required is estimated at 488 milliamps equating to 2.44 watts at five volts. This may be a little high for continuous operation powered only by a small solar cell array. If the HDLC power is secured and the processor executes a HALT instruction, waiting for a timer interrupt to restart operation, the required current can be reduced by at least 400 milliamps. This will reduce power consumption below 390 milliwatts. Securing just the HDLC will reduce the current by 180 milliamps, reducing the power consumed to 1.54 watts.

Table 2 on page 11 shows processor power consumption for the UoSAT-2 and FO-12. PANSAT power consumption of 2.54 watts lies between the FO-12 requirement of 3.5 watts and the UoSAT-2 usage of one watt. The capability of PANSAT is greater

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than that of UoSAT-2 but less than that of FO-12. This indicates that power consumption is appropriate for the capability of the satellite.

Table 16. LSI AND MSI CIRCUIT STATIC POWER CONSUMPTION

Device	Current per device (μ amps)	Number of devices	Total current (μ amps)
54HC00	40	1	40
54HC04	40	5	200
54HC32	40	3	120
54HC73	80	1	80
54HC138	160	9	1440
54HC139	160	1	160
54HC161	160	1	160
54HC245	160	2	320
54HC573	160	3	480
54HC4016	40	2	80
54HC4051	160	5	800
		Total:	3880

Table 17. LSI POWER CONSUMPTION

Device	Operating current (milliamps) at 5 MHz
80C86RH	50
82C85RH	30
82C54RH	10
82C59RH	5
82C55RH	output drive (up to 3)
ICL7115	6
8273	180
Total:	284

I. COMMENTS ON THE DESIGN

To properly survive in the space environment, all circuits must meet military temperature range specifications. Additionally, they should be procured in hermetically

Table 18. MEMORY DEVICE POWER CONSUMPTION

Device	Standby current (milliamps)	Number of devices	Total standby current (milliamps)	Operating current (milliamps)
ROM (6616RH)	0.110	4	0.440	82.5
Vital RAM (CDM6264)	2.0	2	4.0	15
Bulk RAM (CDM62256)	1.0	16	16.0	90
Total			20.44	

sealed. side brazed packages. This is in addition to the radiation hardened or high reliability specifications mentioned above.

No additional drive has been added to RD*. WR*, or M IO. Additional drive on these control signals does not appear to be necessary. This assumption may need to be changed if testing shows additional drive is needed. Sufficient margin exis's in all read and write timings for the additional delays that would be imposed.

The design has been kept simple both to keep power consumption low and to reduce the probability of failure from complexity. Fairly generous timing margins have been enforced to ensure data is transferred reliably.

The differentiation between vital and non-vital RAM may be fairly artificial. especially if all RAM is implemented with the same devices. A more elegant solution might delete this distinction. Several independently decoded sections of RAM could be provided. On reset. the kernel would test all sections and mark sect'ons that fail as unavailable. This would increase the complexity of the kernel that must be present in ROM. Additionally. programs uploaded must be dynamically relocatable as any section of memory can be presumed to be unavailable. However. system operation would still be affected if low memory containing the interrupt table were unavailable. Even this difficulty could be avoided if some form of dynamic decoding were available. After identifying usable memory, the processor configures memory so that one of the usable sections occupies low memory. One possible dynamic decoding circuit is shown in Figure 31 on page 74. This provides eight possible mappings of eight 64 kilobyte memory sections into the low 512 kilobytes of memory. This circuit adds a 24 nanosecond delay to decoding (through the EXOR gate). Any single failed section of memory can be moved to the

highest address (within the 512 kilobyte space). This and other enhancements to PANSAT memory reliability provide areas for further study.

This design did not explicitly provide a capability to expand into a distributed processing network for more complicated systems such as ORION. This capability can be added by adding an additional 82C55RH parallel port to the unused section of I/O space. This parallel port can be configured for bi-directional, parallel data transfers to two other processors. Thus, a ring network of processors could be established. This capability is not required for PANSAT and will not be examined further.

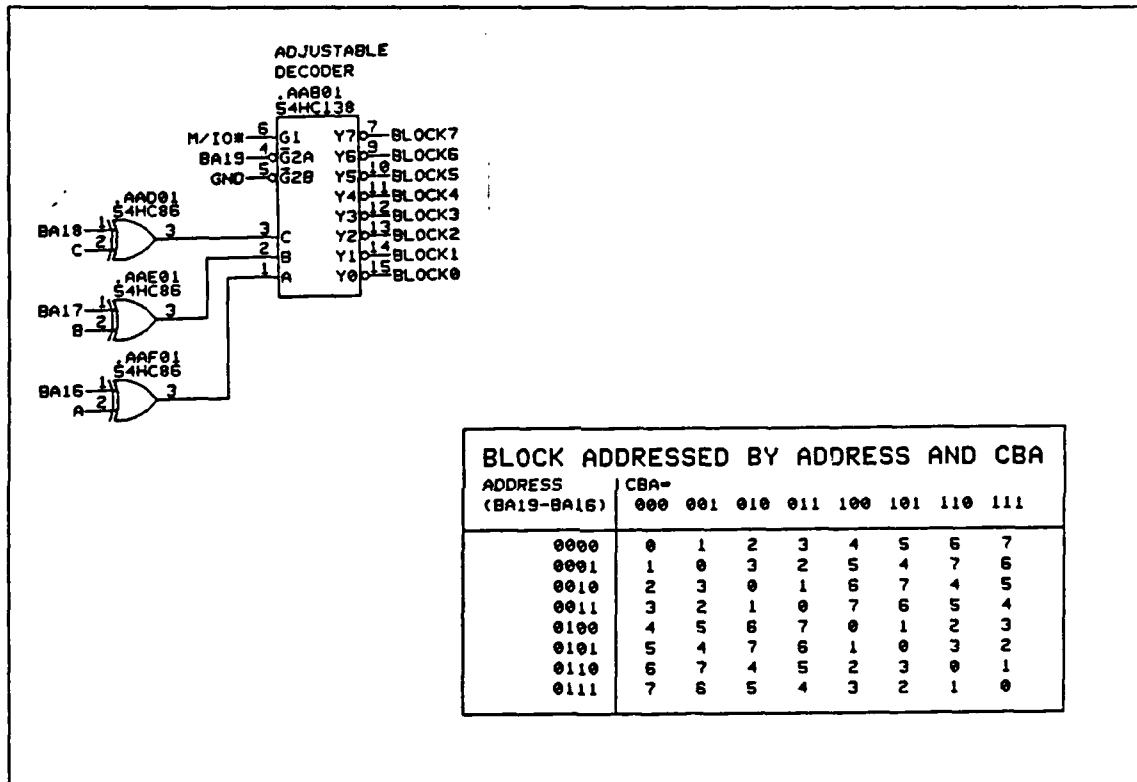| BLOCK ADDRESSED BY ADDRESS AND CBA								
ADDRESS (BA19-BA16)	CBA= 000	001	010	011	100	101	110	111
0000	0	1	2	3	4	5	6	7
0001	1	0	3	2	5	4	7	6
0010	2	3	0	1	6	7	4	5
0011	3	2	1	0	7	6	5	4
0100	4	5	6	7	0	1	2	3
0101	5	4	7	6	1	0	3	2
0110	6	7	4	5	2	3	0	1
0111	7	6	5	4	3	2	1	0

Figure 31.   Dynamic memory decoding circuit and resulting mappings

IV. RELIABILITY ANALYSIS

PANSAT is a relatively simple satellite. It is not stabilized and has neither a transfer rocket motor nor attitude control thrusters. Therefore a processor error cannot cause the satellite to de-orbit prematurely or directly endanger human life. It cannot cause an error in antenna pointing that would prevent communications with the satellite. A typical processor error will cause experiment data to be lost or a message to become garbled. The most impact a processor failure could have would be one that caused the transmitter to remain continuously keyed. This could disrupt communications on the frequency used by the satellite. (This may be self correcting, as continuous transmission may require more power than can be supplied by the solar cells.) At worst, complete failure will cause a mission failure. Presuming the reset system works through the communications link, the processor can be reinitialized after an error causes a program abort. The requirement is to keep the error rate low enough that useful work can be accomplished between system errors.

Because of the small size and low (relative to typical satellite projects) cost of PANSAT, n-module redundancy and voting techniques are not appropriate. These would increase complexity, size, and power consumption beyond the capability of the satellite. Additionally, the increased complexity may of itself cause failures.

Presuming the hardware is operating correctly, the burden for reliable operation falls to the software. An initial list of software requirements is listed in the appendix.

The design of PANSAT has centered on several reliability concepts. These are, fault avoidance, fault detection, and fault tolerant features.

A. FAULT AVOIDANCE

Fault avoidance features minimize the possibility of fault occurrence. PANSAT has two major fault avoidance features. First, system timing has been analyzed to ensure that all data transfers will occur reliably. As the components age and are exposed to radiation, timing margins may be reduced. Leaving at least 50 nanoseconds margin on all critical paths will help minimize errors caused by the effects. Second, the system design has been kept simple overall. No exotic circuits or methods are used. Every effort has been made to eliminate bus contention. The following items also contribute to fault avoidance:

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- The processor and associated LSI circuitry (except HDLC and A D converter) are available in radiation hardened versions.

- All SSI and MSI components are available in high-reliability versions. (Radiation hardened versions of these circuits are also available if required.)

- PROM and vital RAM is implemented in radiation hardened devices.

- Bulk RAM is available in high-reliability versions.

B. FAULT DETECTION

The major fault detection feature is the watchdog timer. The watchdog timer is implemented to reset the processor if a failure has caused the processor to HALT, enter an infinite loop, or otherwise suspend normal program execution. A correctly operating processor will reset the watchdog periodically. If the processor does not reset the watchdog, the non-maskable interrupt will reinitialize the processor when the timer count expires. This feature is dependent on proper software implementation for operation.

C. FAULT TOLERANCE

Two major features have been included in the design to allow the processor to continue operation if a circuit or device fails. First, two redundant sections of PROM are provided. The reset line toggles PROM selection. Corruption of the program stored in one PROM will still allow correct initialization from the alternate PROM on the next reset. The second fault tolerant feature is the four redundant memory sections. Failure of one section will not affect the remaining sections. In addition, this redundancy could be extended to the vital RAM by using an adjustable decoding scheme.

D. FAILURE MODES

There are several single point failure items in this system. Failure of any of the following will cause complete system failure:

- 80C86RH processor
- 82C85 clock generator (and clock crystal)
- 82C59RH interrupt controller
- 54HC245 data bus transceivers
- 54HC573 address latches
- peripheral device chip select (54HC138)
- 8273 HDLC controller

With the exception of the 8273, all these devices are available in radiation-hardened or high-reliability versions. The 80C86RH exhibits a failure rate of 0.00383 percent per thousand hours [Ref. 6: p. 9-5]. (This and all following rates are at +55°C.) The remaining 54HC type circuits exhibit a failure rate of 0.0004 percent per thousand hours [Ref. 15: p. 70]. (These figures are for the CD54HC version.) Failure rates for the 8273 are not specified in Reference 13. However, this circuit approaches the 80C86 in complexity. The standard (not radiation hardened) version of the 80C86 exhibits a failure rate of 0.025 percent per thousand hours. If the 8273 failure rate were five times worse than the 80C86, this would equate to 0.125 percent failures per thousand hours. During the 13,100 hour mission of PANSAT, this would be a 1.637 percent probability of failure. (A factor of five was used to account for the increased stress of orbital environment.) The 8273 is then the single item most likely to cause mission failure. Although an extensive fault tree analysis was not conducted, a first order estimate based on the 8273 reliability indicates that the design will have approximately 98 percent probability of completing the required lifetime.

Several other devices could cause partial mission failure if they malfunction. These are:

- 82C54 timer
- 54HC161 divide by 16 circuit
- ICL7115 A D converter
- 82C55RH parallel port

Failure of these devices will not prevent communication with the satellite or can be worked around to restore the function. For example, failure of the ICL7115 A D converter will not directly preclude communication with the satellite, thereby causing mission failure. (There may be an indirectly cause, such as this failure causing the power monitoring circuit to incorrectly charge the batteries.) The 54HC161 will impact both the ICL7115 and the timer if it fails. The 54HC161 may therefore be a candidate for duplication.

Within the allowable complexity, cost, and power budget, the processor design presented is sufficiently reliable. Verification of reliable design depends upon actual operation. Increasing HDLC reliability to increase overall design reliability is an area for further study.

V. CONCLUSIONS AND RECOMMENDATIONS

The PANSAT definition depends on a ground station that can communicate in the AX.25 format. At present, NPS does not have such a communication capability. Ground station development and testing need not wait on PANSAT. The ground station should be up and operating with current amateur satellites, such as the FO-12, to provide a proven ground station before launch of PANSAT. Therefore, the construction of an amateur satellite ground station that communicates in the AX.25 format should be undertaken.

Maintaining acceptable throughput on the store and forward link requires a low bit error rate. PANSAT is unstabilized and therefore must use omni-directional receive and transmit antennas. PANSAT also has only relatively low power available from the solar cell array. Both of these limitations will have a negative impact on the communications power budget, and therefore, on the bit error rate. The communications package must be carefully designed to maintain acceptable bit error rates under these constraints.

The functions of PANSAT have been examined and computing requirements for these functions determined. A design has been specified that meets these requirements. This design included:

- Four kilobytes of radiation hardened PROM.

- 16 kilobytes of radiation hardened, vital RAM,

- 512 kilobytes of high reliability, non-vital RAM, divided into four independent sections,

- seven analog control channels (expandable to 15) for power system and experiment control,

- 36 telemetry input channels (expandable to 64) with a 14 bit A/D converter for telemetry collection,

- a hardware HDLC protocol implementation for the communication system, and

- expansion capability to meet future ORION distributed processing needs.

Although every effort has been made to ensure this design is correct, it is in essence a paper design and as such is subject to limitations. Implementation of the design and proving its effectiveness remain as follow-on thesis topics. Due to unknown specifics about other satellite subsystems, several items have been incompletely specified. These are:

- Reset interface to communications system.

- HDLC interface to communications system.

- RC value for Schmidt trigger reset input (depends on power system specifics).

- Interface to get-away special canister while on board the shuttle.

- 15 MHz crystal load capacitance (depends on specific crystal).

- Power and experiment control.

- Telemetry specifics (including whether the A/D precision desired will require op-amps to maintain input signal levels).

While many questions remain to be answered, it is hoped that this first design attempt on PANSAT will serve as a launching point for the additional work required to bring up PANSAT as a viable system.

APPENDIX   SOFTWARE REQUIREMENTS

This is a partial list of requirements placed on the software by the particular hardware configuration. There are two possible implementations for loading the software. The kernel may be completely contained in the PROM. Alternatively, only a loader is contained in the PROM. This loader will perform the initial configuration on reset, then prepare the processor to receive the kernel via the communications link. This is shown below as loader initialization and system initialization. If the entire program can be held in PROM, these steps should be combined.

A. LOADER INITIALIZATION

A jump to the initialization service routine must be located at address FFFF0h (within the PROM). This loader routine must:

- Configure the 80C55RH for mode 0 output and set initial device status through port C.

- Set the 8273 (HDLC) operating mode.

- Set the 80C59RH (interrupt controller) operating mode and initialize interrupt numbers for CD*, RxINT, and TxINT.

- Set interrupt vectors for CD*, RxINT, and TxINT in the interrupt vector table.

The initialization routine will then wait for the store and forward program to be uploaded. A variation would not initially power up the 8273, but use the CD* interrupt as a signal to activate and program the 8273, then receive the program. In addition, security is required to ensure that only an authorized ground station can upload the initial program.

B. KERNEL INITIALIZATION

The kernel must perform the following initializations when it is uploaded:

- Store interrupt vectors for NMI (watchdog) and seven 82C59RH interrupts.

- Set 82C59RH operating mode, initialize interrupt vector numbers, and unmask required interrupts.

- Set watchdog timer mode and start timer.

The kernel may then begin normal operations.

C. REAL TIME KERNEL

The real time kernel performs the following functions:

- power management

- manage the store and forward message system, including scheduling transmissions and managing the message buffer.

- schedule telemetry collection

- routinely reset the watchdog timer (this must not occur inside an interrupt routine or it will not catch system malfunctions)

- provide security for commands so only authorized ground stations can execute commands or upload revised programming

- receive and execute commands

D. INTERRUPTS

Several interrupts are assigned to specific events. The two 82C54RH timer interrupts may be used by the programmer to schedule events. Dedicated interrupts are:

- TxINT: provide next byte of transmit data to the 8273

- RxINT: read next byte of received data from 8273

- EOC: read conversion result from ICL7115

- CD: configure 8273 to receive data (This interrupt should be masked if the 8273 already has power and is configured for operation.)

The 8273 FLAGDET* interrupt may be used as needed by the software designer.

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